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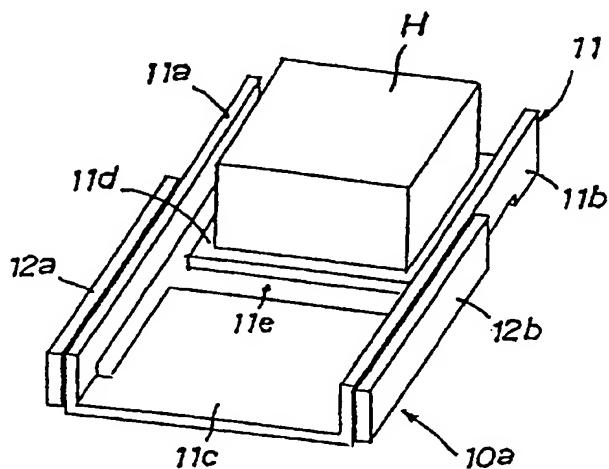
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## (54) Piezoelectric/electrostrictive device and method of producing the same

(57) A piezoelectric/electrostrictive device that includes a base 11 having a pair of right and left movable parts 11a, 11b and a fixing part 11c disposed at one end thereof as well as piezoelectric/electrostrictive elements 12a, 12b disposed on the sides of the movable parts 11a, 11b of the base 11 is fabricated to have a construction with fewer components.

The piezoelectric/electrostrictive device having a construction with fewer components is provided by adopting a base 11 having an integral structure formed by bending an original plate stamped into a shape that delineates a plane development of the base, as the base of the piezoelectric/electrostrictive device.

Fig. 2



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**Description****BACKGROUND OF THE INVENTION****1. Field of the Invention**

[0001] The present invention relates to a piezoelectric/electrostrictive device and a method of producing the same.

**2. Description of the Background Art**

[0002] As one form of piezoelectric/electrostrictive device, there are known a piezoelectric/electrostrictive device of a form that includes a base having a pair of right and left movable parts and a fixing part that connects the movable parts with each other at one end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base, and a piezoelectric/electrostrictive device of a form that includes a base having a pair of right and left movable parts, a fixing part that connects the movable parts with each other at one end thereof, and a mounting part that connects the movable parts with each other at the other end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base, as disclosed in the specification of European Patent EP1017116A2.

[0003] The piezoelectric/electrostrictive device of such a form has a function of operating the movable parts caused by the displacement operation of the piezoelectric/electrostrictive element or a sensing function of sensing the displacement of the movable parts input from the side that is sensed, with the use of the piezoelectric/electrostrictive element. By effectively using these functions, the piezoelectric/electrostrictive device is used in a wide range of fields such as described below.

[0004] Namely, the piezoelectric/electrostrictive devices of such a form are used as active elements such as various transducers, various actuators, frequency region functional components (filters), transformers, vibrators and resonators for communication or mechanical power, oscillators, and discriminators, various sensor elements such as supersonic wave sensors, acceleration sensors, angular velocity sensors, impact sensors, and mass sensors, and various actuators that are put to use for displacement, positioning adjustment, and angle adjustment mechanism for various precision components of optical instruments and precision apparatus.

[0005] Meanwhile, the piezoelectric/electrostrictive device of such a form is formed typically by cutting a device master into a suitable size, and the device master is constructed by bonding a piezoelectric/electrostrictive element onto both of the front and rear surfaces of a base master via an adhesive, or is constructed by integrally forming these. Here, the base master is constructed by laminating and baking plural sheets.

[0006] Thus, the piezoelectric/electrostrictive device having such a form has a large number of construction components, so that the device is produced at a high cost and through a cumbersome assembling work.

5 Moreover, since the construction components are bonded via an adhesive, there arises a variation of adhesion between the construction components, giving rise to a fear that the device characteristics may be adversely affected.

10 [0007] Further, the piezoelectric/electrostrictive device having such a form is produced by adopting means to cut a device master suitably into a large number of devices. Therefore, the piezoelectric/electrostrictive devices formed by cutting are contaminated with dusts 15 generated at the time of cutting, cutting liquid, and organic components such as an adhesive or wax used for holding the device master at the time of cutting, so that it is not easy to clean the piezoelectric/electrostrictive device.

20 [0008] Also, in the case where the base is constructed with ceramics, one must adopt a hard ceramic material such as zirconia, since the ceramics are liable to be split. Even if a hard ceramic material is adopted, one must choose a suitable cutting condition so as not to generate 25 loss of material nicks or cracks. Further, since the base is made of a hard ceramic material, the machining process is difficult to be designed and, in order to increase the number of machining products, one must give a careful consideration such as use of a large number of 30 machining apparatus having different functions.

[0009] The base can be constructed with a metal material; however, the metal material gives rise to an oxidized end surface by friction heat during the cutting process and burrs remained on the processed end surface, so that one must add another step of removing 35 these. Further, the piezoelectric/electrostrictive element can be tested only after the device master is cut.

[0010] Meanwhile, the device cut out from the device master is preferably cleaned by adopting ultrasonic 40 cleaning that can easily remove the contamination. However, if a strong ultrasonic wave is used to obtain a high cleaning effect in ultrasonic cleaning, the device may be damaged, and the piezoelectric/electrostrictive element maybe broken or peeled off from the base. For 45 this reason, if the ultrasonic cleaning is adopted, one must select a weak ultrasonic wave that does not give damages to the device. However, if such a cleaning condition is adopted, a long period of time is needed in removing the contamination that has adhered at the time 50 of cutting.

[0011] Dust generation from the piezoelectric/electrostrictive device may cause the following problems. For example, in the case where the piezoelectric/electrostrictive device is used in an actuator of a magnetic 55 head in a hard disk drive, if dust is generated in the drive, the dust may cause crash of the floating slider onto the medium, thereby raising a fear of data destruction. Also, for the piezoelectric/electrostrictive device itself, the

dust may adhere to the electrode of the piezoelectric/electrostrictive element, thereby giving rise to a fear of short circuit. For this reason, a high level of cleaning is required not only in the hard disk drive but also in the device itself.

[0012] Therefore, an object of the present invention is to solve the aforementioned problems of the prior art by allowing the base constituting the piezoelectric/electrostrictive device of that form to have an integral structure using one sheet of flat plate as an original plate.

## SUMMARY OF THE INVENTION

[0013] The present invention relates to a piezoelectric/electrostrictive device and a method of producing the piezoelectric/electrostrictive device. The piezoelectric/electrostrictive devices according to the present invention are piezoelectric/electrostrictive devices provided in the following three types of forms.

[0014] A piezoelectric/electrostrictive device of the first form according to the present invention is a piezoelectric/electrostrictive device that includes a base having a pair of right and left movable parts and a fixing part that connects the movable parts with each other at one end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base.

[0015] A piezoelectric/electrostrictive device of the second form according to the present invention is a piezoelectric/electrostrictive device that includes a base having a pair of right and left movable parts, a fixing part that connects the movable parts with each other at one end thereof, and a mounting part that is separate from the fixing part and connects the movable parts with each other at the other end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base.

[0016] A piezoelectric/electrostrictive device of the third form according to the present invention is a piezoelectric/electrostrictive device that includes a base having a pair of right and left movable parts, a fixing part that connects the movable parts with each other at one end thereof, a mounting part that is separate from the fixing part and connects the movable parts with each other at the other end thereof, and a connecting part that is integral with the mounting part and surrounds the mounting part, the movable parts, and the fixing part as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base.

[0017] Now, in the piezoelectric/electrostrictive device of the first form according to the present invention, the base is constructed with one sheet of flat plate; the fixing part has a flat plate shape; and the movable parts are erect by a predetermined height from side peripheries of the fixing part to face each other and extend beyond the other end of the fixing part along the side peripheries of the fixing part.

[0018] The piezoelectric/electrostrictive device can

be constructed in such a manner that a slit-shaped groove extending from the other end of the fixing part intervenes between a base part of the movable parts constituting the base and the side peripheries of the fixing part.

[0019] Further, the piezoelectric/electrostrictive device can be constructed in such a manner that a connecting portion between a base part of the movable parts and the side peripheries of the fixing part constituting the base has a circular arc shape.

[0019] In the piezoelectric/electrostrictive device of the second form according to the present invention, the base is constructed with one sheet of flat plate; the fixing part and the mounting part have a flat plate shape; and the movable parts are erect by a predetermined height

from side peripheries of the fixing part and the mounting part to face each other and extend along the side peripheries of the fixing part and the mounting part.

[0020] The piezoelectric/electrostrictive device can be constructed in such a manner that a laterally extending

slit-shaped groove intervenes between the other end of the fixing part and the one end of the mounting part constituting the base, and a longitudinally extending slit-shaped groove intervenes between a base part of the movable parts and the side peripheries of the fixing part

and the mounting part. Alternatively, the piezoelectric/electrostrictive device can be constructed in such a manner that a laterally and longitudinally extending rectangular opening intervenes between the other end of the fixing part and the one end of the mounting part constituting the base.

[0021] Further, the piezoelectric/electrostrictive device can be constructed in such a manner that a connecting portion between a base part of the movable parts and the side peripheries of the fixing part constituting the base has a circular arc shape.

[0021] In the piezoelectric/electrostrictive device of the third form according to the present invention, the base is constructed with one sheet of flat plate; the fixing part and the mounting part have a flat plate shape; the movable parts are erect by a predetermined height from

side peripheries of the fixing part and the mounting part to face each other and extend along the side peripheries of the fixing part and the mounting part; and the movable parts, the fixing part, and the mounting part are positioned within a central space of the connecting part.

[0022] The piezoelectric/electrostrictive device can be constructed in such a manner that the central space of the connecting part on a side of the one end of the fixing part is either closed or open. Further, the piezoelectric/electrostrictive device can be constructed in such

a manner that a connecting portion between a base part of the movable parts and the side peripheries of the fixing part constituting the base has a circular arc shape. Still further, the piezoelectric/electrostrictive device can be constructed in such a manner that a connecting portion between a base part of the movable parts and the side peripheries of the fixing part and the mounting part constituting the base has a circular arc shape.

[0023] The piezoelectric/electrostrictive devices of

these forms according to the present invention can employ the following constructions, namely, a construction such that the base is constructed with a flat plate made of metal; a construction such that a central portion, as viewed in a length direction, of the movable parts constituting the base is formed to have a smaller thickness than other portions of the movable parts; a construction such that the movable parts constituting the base has a reinforcing part located at an end thereof on the fixing part side and bent from an upper edge of the end to extend towards and abut against a surface of the fixing part; a construction such that the movable parts constituting the base has a reinforcing part located at an end thereof on the fixing part side and bent from a front edge of the end to extend towards an inner side and abut against a surface of the fixing part; and a construction such that a reinforcing member intervenes between the movable parts on the fixing part constituting the base. Furthermore, the piezoelectric/electrostrictive devices can employ a construction such that the fixing part constituting the base extends from the one end side of the movable parts and is enlarged as compared with a case of being located within the movable parts, and a construction such that the mounting part constituting the base extends from the other end side of the movable parts and is enlarged as compared with a case of being located within the movable parts.

[0024] The methods of producing a piezoelectric/electrostrictive device according to the present invention are directed to methods of respectively producing piezoelectric/electrostrictive devices of the above-described three forms, and the methods of producing the piezoelectric/electrostrictive devices of these various forms are as follows.

[0025] The first production method according to the present invention is a method of producing a piezoelectric/electrostrictive device of the first form according to the present invention, wherein the method includes the steps of preparing a flexible and bendable flat plate as a material for forming the base, stamping the flat plate into a shape that delineates a plane development of the base to form a stamped structure, and bending the stamped structure at a predetermined site to form the base having the movable parts and the fixing part.

[0026] The production method can be carried out in such a manner that the stamped structure has a gate-shaped opening composed of a pair of straight side grooves located at right and left sides of a rectangular flat plate and extending along side peripheries and an opening formed by cutting and removing a portion between the two grooves, and the side peripheries of the flat plate are bent along the side grooves to form the side peripheries into the movable parts and to form a portion between the side grooves into the fixing part.

[0027] The second production method according to the present invention is a method of producing a piezoelectric/electrostrictive device of the second form according to the present invention, wherein the method in-

cludes the steps of preparing a flexible and bendable flat plate as a material for forming the base, stamping the flat plate into a shape that delineates a plane development of the base to form a stamped structure, and bending the stamped structure at a predetermined site to form the base having the movable parts, the fixing part, and the mounting part.

[0028] The production method can be carried out in such a manner that the stamped structure has an H-shaped opening composed of a pair of straight side grooves located at right and left sides of a rectangular flat plate and extending along side peripheries and a straight central groove that connects the two side grooves with each other at a middle part, and the side peripheries of the flat plate are bent along the side grooves to form the side peripheries into the movable parts and to form a portion between the side grooves into the fixing part and the mounting part. Further, the production method can be carried out in such a manner that the stamped structure has a rectangular opening at a central part of a rectangular flat plate, and side peripheries of the flat plate are bent along side peripheries of the opening to form the side peripheries into the movable parts and to form a portion between the side peripheries into the fixing part and the mounting part.

[0029] The third production method according to the present invention is a method of producing a piezoelectric/electrostrictive device of the third form according to the present invention, wherein the method includes the steps of preparing a flexible and bendable flat plate as a material for forming the base, stamping the flat plate into a shape that delineates a plane development of the base to form a stamped structure, and bending the stamped structure at a predetermined site to form the base having the movable parts, the fixing part, the mounting part, and the connecting part.

[0030] The production method can be carried out in such a manner that the stamped structure has a rectangular flat plate part located inside a central opening of a rectangular flat plate and has an H-shaped opening composed of a pair of straight side grooves located at right and left sides of the flat plate part and extending along side peripheries and a straight central groove that connects the two side grooves with each other at a middle part, and the side peripheries of the flat plate part are bent along the side grooves to form the side peripheries into the movable parts, to form a portion between the side grooves into the fixing part and the mounting part, and to form a portion around the central opening into the connecting part.

[0031] The production methods according to the present invention can be carried out in such a manner that a flat plate made of metal is adopted as a material for forming the base, and an opening of the stamped structure is formed by stamping simultaneously with stamping the flat plate or formed by a hole-forming process after stamping the flat plate.

[0032] Now, it is essential in the principle of operation

that the fixing part or the fixing part and the mounting part are closely connected to the two flexible side peripheries. Since these are integrally formed in the piezoelectric/electrostrictive devices according to the present invention, the most preferable modes are embodied in view of the principle of operation.

[0033] For example, in the case where the aforesaid two or three essential parts are made of metal and welded with each other, one must take into consideration the problems in the heat treatment step, such as distortion by heat of welding, deterioration of material quality, and annealing. In contrast, in the case where the base is integrally formed as in the piezoelectric/electrostrictive devices according to the present invention, these fears are absent even if the base is made of metal, and also an improvement in the strength of the connecting part by process hardening at the time of integral forming can be expected.

[0034] If the piezoelectric/electrostrictive device according to the present invention is combined with a component (for example, a magnetic head of a hard disk drive), the height after assemblage will not be equal to the sum of the height of the component and the height of the device but will be smaller than the sum, thereby producing an advantage that the device can have a compact construction. Regarding the height of the device, the thickness of the plate of the movable parts and the thickness of the adhesive are added to the height of the component; however, as compared with the known devices described at the beginning, the height after assemblage can be reduced, thereby providing an effect of space reduction. Further, the assemblage can be carried out with ease simply by bonding the component onto the fixing part, and the bonding area can be enlarged, thereby advantageously increasing the bonding strength and providing a structure that will not be easily dropped off by impact.

[0035] In the first and second piezoelectric/electrostrictive devices among the piezoelectric/electrostrictive devices according to the present invention, it is easy in view of their structure to form, by pressing, a recess to accommodate an adhesive at the bonding site of the mounting part and the fixing part to the component to be controlled. This can increase the bonding strength and can restrain the squeeze-out of the adhesive. Also, it is easy to form a standard position (hole or the like) for positioning that is used in assembling the component. For this reason, the assembling precision in assembling the component onto the mounting part on the device and in mounting the fixing part onto the gimbal of the suspension in later steps can be increased to further improve the yield of the products. By testing the piezoelectric/electrostrictive element in advance before assembling the device, the deterioration of device characteristics after assembling the device can be greatly reduced.

[0036] It goes without saying that the piezoelectric/electrostrictive device of the third form according to the

present invention can produce the functions and effects that are produced by the first and second piezoelectric/electrostrictive devices. In particular, since the third piezoelectric/electrostrictive device has a connecting part that is integral with the mounting part, the device provides a great advantage that the connecting part can be allowed to function as a gimbal for supporting the magnetic head (slide'r) of the hard disk drive.

[0037] The piezoelectric/electrostrictive devices according to the present invention are based on the piezoelectric/electrostrictive devices of the above-described three forms. In these piezoelectric/electrostrictive devices having a basic structure, the base of each device has an integral structure formed from an original plate made of a flat plate, so that the base is in principle constructed with only one construction component. Therefore, the construction components of each device are two kinds, namely, the base and the piezoelectric/electrostrictive elements, so that the number of construction components of the piezoelectric/electrostrictive device can be greatly reduced, and the number of steps for assembling the construction components can be greatly reduced, thereby leading to large reduction of costs.

[0038] Further, in each piezoelectric/electrostrictive device according to the present invention, since the number of construction components is extremely small and the number of bonding sites between the construction components is extremely small, there is little or no variation in the adhesion between the construction components, whereby the piezoelectric/electrostrictive device has device characteristics in which the set precision is high.

[0039] Further, in forming each piezoelectric/electrostrictive device according to the present invention, there is no need to adopt means for cutting a device master at numerous sites, so that there is no contamination caused by dusts and other contaminants generated at the time of cutting the device master. For this reason, if the base and the piezoelectric/electrostrictive elements are cleaned in advance in assembling the piezoelectric/electrostrictive device, the assembled piezoelectric/electrostrictive device has little or no contamination, thereby providing a great advantage that the step of cleaning the piezoelectric/electrostrictive device can be omitted or carried out in a simple manner.

[0040] Regarding the piezoelectric/electrostrictive devices according to the present invention, the piezoelectric/electrostrictive device of the first form, the piezoelectric/electrostrictive device of the second form, and the piezoelectric/electrostrictive device of the third form can be produced with ease and at a low cost respectively by the first method according to the present invention, the second method according to the present invention, and the third method according to the present invention.

## BRIEF DESCRIPTION OF THE DRAWINGS

[0041] These and other objects, features, aspects, and advantages of the present invention will become more apparent from the following detailed description of the present invention when taken in conjunction with the accompanying drawings, in which,

Figs. 1A to 1K are perspective views respectively illustrating eleven types of embodiments of the piezoelectric/electrostrictive devices according to the present invention;

Fig. 2 is a perspective view illustrating a state in which a component to be controlled is mounted on the first piezoelectric/electrostrictive device of the second form according to the present invention;

Figs. 3A and 3B are a perspective view illustrating an original plate of a base constituting the first piezoelectric/electrostrictive device, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 4A and 4B are a perspective view illustrating a state of assembling the first piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 5A and 5B are a perspective view illustrating an original plate of a base constituting the second piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 6A and 6B are a perspective view illustrating a state of assembling the second piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 7A and 7B are a perspective view illustrating an original plate of a base constituting the third piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 8A and 8B are a perspective view illustrating a state of assembling the third piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 9A and 9B are a perspective view illustrating an original plate of a base constituting the fourth piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 10A and 10B are a perspective view illustrating a state of assembling the fourth piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive

device, respectively;

Figs. 11A and 11B are a perspective view illustrating an original plate of a base constituting the fifth piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 12A and 12B are a perspective view illustrating a state of assembling the fifth piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 13A and 13B are a perspective view illustrating an original plate of a base constituting the sixth piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 14A and 14B are a perspective view illustrating a state of assembling the sixth piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 15A and 15B are a perspective view illustrating an original plate of a base constituting the seventh piezoelectric/electrostrictive device of the seventh embodiment according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 16A and 16B are a perspective view illustrating a state of assembling the seventh piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 17A and 17B are a perspective view illustrating an original plate of a base constituting the eighth piezoelectric/electrostrictive device of the first form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 18A and 18B are a perspective view illustrating a state of assembling the eighth piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Fig. 19 is a perspective view illustrating a state in which a component to be controlled is mounted on the first modification of the eighth piezoelectric/electrostrictive device;

Fig. 20 is a perspective view illustrating the second modification of the eighth piezoelectric/electrostrictive device;

Figs. 21A and 21B are a perspective view illustrating an original plate of a base constituting the ninth piezoelectric/electrostrictive device of the second form according to the present invention, and a perspective view illustrating the base formed by bending the original plate, respectively;

Figs. 22A and 22B are a perspective view illustrating a state of assembling the ninth piezoelectric/electrostrictive device, and a perspective view illustrating the assembled piezoelectric/electrostrictive device, respectively;

Figs. 23A and Fig. 23B are perspective views illustrating two examples of piezoelectric/electrostrictive elements adopted as the piezoelectric/electrostrictive element constituting the piezoelectric/electrostrictive device according to the present invention;

Figs. 24A and Fig. 24B are perspective views illustrating two other examples of piezoelectric/electrostrictive elements adopted as the piezoelectric/electrostrictive element constituting the piezoelectric/electrostrictive device according to the present invention;

Fig. 25 is a perspective view illustrating the first piezoelectric/electrostrictive device in which the piezoelectric/electrostrictive element shown in Fig. 24B is adopted as the piezoelectric/electrostrictive element;

Fig. 26 is a plan view illustrating a non-operating state of the piezoelectric/electrostrictive device of Fig. 25;

Figs. 27A and 27B are waveform diagrams respectively showing voltages applied to the two piezoelectric/electrostrictive elements of the piezoelectric/electrostrictive device of Fig. 25;

Fig. 28 is a plan view illustrating an operating state of the piezoelectric/electrostrictive device of Fig. 25; Fig. 29 is a perspective view illustrating the first modification of the first piezoelectric/electrostrictive device;

Fig. 30 is a perspective view illustrating the second modification of the first piezoelectric/electrostrictive device;

Fig. 31 is a perspective view illustrating the tenth piezoelectric/electrostrictive device of the third form according to the present invention

Figs. 32A and 32B are a perspective view illustrating an original plate of a base constituting the piezoelectric/electrostrictive device of Fig. 31, and a perspective view illustrating the base formed by bending the original plate, respectively;

Fig. 33 is a perspective view illustrating the eleventh piezoelectric/electrostrictive device of the third form according to the present invention

Figs. 34A and 34B are a perspective view illustrating an original plate of a base constituting the piezoelectric/electrostrictive device of Fig. 33, and a perspective view illustrating the base formed by bending the original plate, respectively;

Fig. 35 is a perspective view illustrating a hard disk drive having the tenth piezoelectric/electrostrictive device mounted thereon; and

Figs. 36A and 36B are a plan view and a side view, respectively, of a suspension having the tenth pie-

zoelectric/electrostrictive device mounted thereon.

## DESCRIPTION OF THE PREFERRED EMBODIMENTS

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**[0042]** The piezoelectric/electrostrictive devices according to the present invention are: a piezoelectric/electrostrictive device of the first form that includes a base having a pair of right and left movable parts and a fixing part that connects the movable parts with each other at one end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base; a piezoelectric/electrostrictive device of the second form that includes a base having a pair of right and left movable parts, a fixing part that connects the movable parts with each other at one end thereof, and a mounting part that is separate from the fixing part and connects the movable parts with each other at the other end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base; and a piezoelectric/electrostrictive device of the third form that includes a base having a pair of right and left movable parts, a fixing part that connects the movable parts with each other at one end thereof, and a mounting part that is separate from the fixing part and connects the movable parts with each other at the other end thereof, and a connecting part that is integral with the mounting part and surrounds the mounting part, the movable parts, and the fixing part as well as a piezoelectric/electrostrictive element disposed on at least one side of the movable parts of the base.

Figs. 1A to 1K illustrate numerous embodiments (first embodiment to eleventh embodiment) of the piezoelectric/electrostrictive devices of various forms.

**[0043]** The first piezoelectric/electrostrictive device 10a shown in Fig. 1A belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention and is used in a state shown in Fig. 2. The first piezoelectric/electrostrictive device 10a is formed by the method shown in Figs. 3 and 4. The first piezoelectric/electrostrictive device 10a is made of a base 11 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 11 is constructed with a pair of right and left long and narrow plate-shaped movable parts 11a, 11b, a flat plate-shaped fixing part 11c that connects the movable parts 11a, 11b with each other at one end thereof, and a flat plate-shaped mounting part 11d that connects the movable parts 11a, 11b with each other at the other end thereof.

**[0044]** An H-shaped opening 11e sections base 11 into movable parts 11a, 11b, fixing part 11c, and mounting part 11d. Opening 11e is made of a pair of right and left side grooves 11e1, 11e2 and a central groove 11e3 that connects the two side grooves 11e1, 11e2 with each other at the central part thereof as viewed in the longitudinal direction. Movable part 11a on the left side is bent at side groove 11e1 along groove 11e1 and is erect perpendicularly to fixing part 11c and mounting part 11d.

Similarly, movable part 11b on the right side is bent at side groove 11e2 along groove 11e2 and is erect perpendicularly to fixing part 11c and mounting part 11d.

[0045] In base 11 having such a construction, piezoelectric/electrostrictive elements 12a, 12b are bonded respectively onto outer sides of the movable parts 11a, 11b via an adhesive made of epoxy resin or the like. Piezoelectric/electrostrictive elements 12a, 12b are each a multi-layer body made of piezoelectric/electrostrictive layers and electrode films. Piezoelectric/electrostrictive elements 12a, 12b are formed to have the same shape as movable parts 11a, 11b and are shorter than movable parts 11a, 11b by a predetermined length. Piezoelectric/electrostrictive elements 12a, 12b are respectively bonded in alignment to the end of movable parts 11a, 11b on the fixing part 11c side, and extend to a site that leaves a predetermined length from the end of movable parts 11a, 11b on the mounting part 11d side.

[0046] In the base 11, a magnetic head H (slider) for a hard disk, which is a component to be controlled, for example, is bonded and fixed onto the upper side of mounting part 11d, and the lower side is bonded and fixed onto a gimbal of the suspension. Here, in this case, the positions of mounting the magnetic head H and the suspension can be changed to fixing part 11c, contrary to the above. This does not change the device functions at all. Also, the positions of mounting the magnetic head H and the suspension with respect to fixing part 11c and mounting part 11d can be changed to a configuration in which the roles of the front and rear surfaces are reversed. This does not change the device functions at all, either. However, the wirings of external electrodes that are brought into contact with the terminals of piezoelectric/electrostrictive elements 12a, 12b must be wired in a reversed manner on the suspension.

[0047] Now, base 11 constituting the piezoelectric/electrostrictive device 10a is formed by using an original plate 11A shown in Fig. 3A as a material for molding and by bending original plate 11A as shown in Fig. 3B. Original plate 11A is a stamped structure that is stamped out from a flexible and bendable flat plate and is formed in a shape that delineates a plane development of base 11. The flat plate constituting the original plate 11A is preferably made of metal in view of strength.

[0048] The flat plate is preferably made of a metal having a Young's modulus of at least 100 GPa and, as a ferrous metals material, one can mention austenite-series stainless steels such as SUS301, SUS304, AISI653, and SUH660, ferrite-series stainless steels such as SUS430 and SUS 434, martensite-series stainless steels such as SUS410 and SUS630, semiaustenite-series stainless steels such as SUS6312 and AISI632, maraging stainless steel, various spring steel materials, and others. As a nonferrous metals material, one can mention superelastic titanium alloys such as a titanium-nickel alloy, brass, cupro-nickel, aluminum, tungsten, molybdenum, beryllium copper, phosphorus bronze, nickel, anickel iron alloy, titanium, and others.

[0049] Original plate 11A is formed by subjecting a flat plate to a stamping process, and is provided with an H-shaped opening 11e. Opening 11e is formed simultaneously at the time of stamping the flat plate, and is made of a pair of straight side grooves 11e1, 11e2 located at right and left sides of original plate 11A and extending to the front and rear ends and a straight central groove 11e3 that connects the two side grooves 11e1, 11e2 with each other at the central parts thereof. Base 11 is formed by perpendicularly bending the right and left side peripheries of original plate 11A at the side grooves 11e1, 11e2 along central lines L1, L2 that extend at the center of the width of the grooves 11e1, 11e2 in the longitudinal direction thereof. By bending the right and left sides of original plate 11A in such a manner, the sites located outside the side grooves 11e1, 11e2 are formed into movable parts 11a, 11b, and the sites on the front end side and on the rear end side of the central groove 11e3 are formed into fixing part 11c and mounting part 11d, respectively.

[0050] In base 11 thus integrally constructed from original plate 11A, piezoelectric/electrostrictive elements 12a, 12b are bonded via an adhesive onto the outer sides of movable parts 11a, 11b as shown in Fig. 4A to form piezoelectric/electrostrictive device 10a shown in Fig. 4B. Piezoelectric/electrostrictive device 10a thus formed functions in the same manner as the conventional piezoelectric/electrostrictive devices of this form and, since base 11 is integrally constructed from original plate 11A, piezoelectric/electrostrictive device 10a produces the following functions and effects.

[0051] Namely, in the first piezoelectric/electrostrictive device 10a, base 11 has an integral structure made of one sheet of original plate 11A alone and is constructed with one construction component. Therefore, the construction components of the device 10a are two kinds, i.e. base 11 and piezoelectric/electrostrictive elements 12a, 12b, so that the number of construction components of piezoelectric/electrostrictive device 10a can be greatly reduced, and the number of steps for assembling the construction components can be greatly reduced, thereby leading to large reduction of costs.

[0052] Further, in the first piezoelectric/electrostrictive device 10a, since the number of construction components is extremely small and the number of bonding sites between the construction components is extremely small, there is little or no variation in the adhesion between the construction components, whereby the first piezoelectric/electrostrictive device 10a has device characteristics in which the set precision is high.

[0053] Further, in forming the first piezoelectric/electrostrictive device 10a, there is no need to adopt means for cutting a device master at numerous sites as in the prior art, so that there is no contamination caused by adhesion of dusts and other contaminants generated at the time of cutting the device master. For this reason, if base 11 and piezoelectric/electrostrictive elements 12a, 12b are cleaned in advance in assembling the first pie-

zoelectric/electrostrictive device 10a, the assembled piezoelectric/electrostrictive device 10a has little or no contamination, thereby providing a great advantage that the step of cleaning the piezoelectric/electrostrictive device 10a can be omitted or carried out in a simple manner.

[0054] The second piezoelectric/electrostrictive device 10b shown in Fig. 1B belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The second piezoelectric/electrostrictive device 10b has a base constructed in a slightly different manner from that of the first piezoelectric/electrostrictive device 10a. Referring to Fig. 6B, the second piezoelectric/electrostrictive device 10b is made of a base 13 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 13 is constructed with a pair of right and left long and narrow plate-shaped movable parts 13a, 13b, a flat plate-shaped fixing part 13c that connects the movable parts 13a, 13b with each other at one end thereof, and a flat plate-shaped mounting part 13d that connects the movable parts 13a, 13b with each other at the other end thereof.

[0055] An H-shaped opening 13e sections base 13 into movable parts 13a, 13b, fixing part 13c, and mounting part 13d. As far as such a construction is concerned, the base 13 of the second piezoelectric/electrostrictive device 10b has the same construction as the base 11 of the first piezoelectric/electrostrictive device 10a.

[0056] However, in base 13, the bent parts 13a1, 13b1, which are the sites for connecting movable parts 13a, 13b to fixing part 13c and mounting part 13d, have a circular arc shape in which the bent parts 13a1, 13b1 are recessed from the surface of fixing part 13c and mounting part 13d. Referring to Fig. 5A, the original plate 13A constituting the base 13 is the same as the original plate 11A of base 11, and has a different bent shape in bending the original plate to form movable parts 13a, 13b. Namely, in the bending process, circular arc-shaped bent parts 13a1, 13b1 are formed at the base part of movable parts 13a, 13b. Referring to Fig. 6A, piezoelectric/electrostrictive elements 12a, 12b are bonded onto the outer sides of movable parts 13a, 13b of the base 13 to form the second piezoelectric/electrostrictive device 10b.

[0057] The second piezoelectric/electrostrictive device 10b has the same functions as the first piezoelectric/electrostrictive device 10a and produces approximately similar actions and effects as the first piezoelectric/electrostrictive device 10a. In particular, since movable parts 13a, 13b are connected to fixing part 13c and mounting part 13d via circular arc-shaped bent parts 13a1, 13b1, the movability of movable parts 13c, 13d is improved to produce high device functions.

[0058] Further, the second piezoelectric/electrostrictive device 10b facilitates making a highly precise degree of orthogonality of movable parts 13a, 13b to fixing part 13c and mounting part 13d, thereby restraining displacements in the flapping direction. Moreover, since

the position of movable parts 13a, 13b in the Y-axis direction with respect to fixing part 13c and mounting part 13d can be set by changing the degree of bending the circular arc-shaped bent parts, the device designing can have a larger width.

[0059] The third piezoelectric/electrostrictive device 10c shown in Fig. 1C belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The third piezoelectric/electrostrictive device 10c has a base constructed to have slightly different parts from those of the second piezoelectric/electrostrictive device 10b, but the other parts are the same.

[0060] Now, referring to Fig. 8B, the third piezoelectric/electrostrictive device 10c is made of a base 14 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 14 is constructed with a pair of right and left long and narrow plate-shaped movable parts 14a, 14b, a flat plate-shaped fixing part 14c that connects the movable parts 14a, 14b with each other at one end thereof, and a flat plate-shaped mounting part 14d that connects the movable parts 14a, 14b with each other at the other end thereof.

[0061] In base 14, the middle portion of movable parts 14a, 14b in the longitudinal is formed into thin parts 14a1, 14b1 for a predetermined length; however, except this point, base 14 is constructed in the same manner as base 13. Further, referring to Fig. 7A, the original plate 14A of base 14 has thin parts 14a1, 14b1 on the right and left sides of an H-shaped opening 14e which are to be formed into movable parts 14a, 14b later. Base 14 is subjected to a bending process along the two-dot chain lines L1, L2 shown in Fig. 7B in the same manner as base 13. Referring to Fig. 8A, piezoelectric/electrostrictive elements 12a, 12b are bonded onto outer sides of movable parts 14a, 14b to form the third piezoelectric/electrostrictive device 10c.

[0062] The third piezoelectric/electrostrictive device 10c has the same functions as the second piezoelectric/electrostrictive device 10b and produces approximately similar actions and effects as the second piezoelectric/electrostrictive device 10b. In particular, since movable parts 14a, 14b are provided with thin parts 14a1, 14b1 that are located in the middle thereof and extending in the longitudinal direction, the movability of movable parts 14a, 14b is more enhanced to produce further high device functions.

[0063] Here, as means for forming thin parts 14a1, 14b1 of original plate 14A, one can adopt a method of reducing the thickness by partially removing the material using chemical etching, microblasting, ion-milling, or the like, or a method of reducing the thickness by cutting through grinding, or the like method. Further, as a special means, one can adopt a plate formed by superposing and bonding one plate that has been drilled to have a hole of a predetermined length onto the other plate without a hole to substitute the site corresponding to the hole for the thin parts, as an original plate.

[0064] The fourth piezoelectric/electrostrictive device 10d shown in Fig. 1D belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The fourth piezoelectric/electrostrictive device 10d has a base constructed to have slightly different parts from those of the first piezoelectric/electrostrictive device 10a, but the other parts are the same.

[0065] Referring to Fig. 10B, the fourth piezoelectric/electrostrictive device 10d is made of a base 15 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 15 is constructed with a pair of right and left long and narrow plate-shaped movable parts 15a, 15b, a flat plate-shaped fixing part 15c that connects the movable parts 15a, 15b with each other at one end thereof, a flat plate-shaped mounting part 15d that connects the movable parts 15a, 15b with each other at the other end thereof, and a pair of right and left reinforcing parts 15f, 15g that extend from an upper fringe on one ends of movable parts 15a, 15b and abut against the surface of fixing part 15c.

[0066] Base 15 is constructed in the same manner as base 11 except that base 15 is provided with reinforcing parts 15f, 15g. Further, referring to Fig. 9A, the original plate 15A of base 15 is provided with portions to become reinforcing parts 15f, 15g that are extending outward from one ends of the right and left sides of an H-shaped opening 15e which are to be formed into movable parts 15a, 15b later. Base 15 is subjected to a bending process along two-dot chain lines L1, L2 and others as shown in Fig. 9B. Referring to Fig. 10A, piezoelectric/electrostrictive elements 12a, 12b are bonded onto outer sides of movable parts 15a, 15b to form the fourth piezoelectric/electrostrictive device 10d.

[0067] The fourth piezoelectric/electrostrictive device 10d has the same functions as the first piezoelectric/electrostrictive device 10a and produces approximately similar actions and effects as the first piezoelectric/electrostrictive device 10a. In particular, fixing part 15c is reinforced by reinforcing parts 15f, 15g. Reinforcing parts 15f, 15g are bonded onto fixing part 15c. As the bonding means therefor, one can adopt a bonding means such as spot welding, press-bonding, caulking, soldering, brazing, or using an adhesive such as epoxy resin or UV-curing type resin or the like. Among these bonding means, spot welding is especially preferable.

[0068] The fifth piezoelectric/electrostrictive device 10e shown in Fig. 1E belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The fifth piezoelectric/electrostrictive device 10e has a base constructed to have slightly different parts from those of the fourth piezoelectric/electrostrictive device 10d, but the other parts are the same.

[0069] Now, referring to Fig. 12B, the fifth piezoelectric/electrostrictive device 10e is made of a base 16 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 16 is constructed with a pair of right and left

long and narrow plate-shaped movable parts 16a, 16b, a flat plate-shaped fixing part 16c that connects the movable parts 16a, 16b with each other at one end thereof, a flat plate-shaped mounting part 16d that connects the movable parts 16a, 16b with each other at the other end thereof, and reinforcing parts 16f, 16g that bend inwardly from the end of movable parts 16a, 16b in a manner like a flange.

[0070] Base 16 is constructed in the same manner as base 15 except that the shape of reinforcing parts 16f, 16g is different from the shape of reinforcing parts 15f, 15g. Further, referring to Fig. 11A, the original plate 16A of base 16 is constructed in such a manner that the right and left sides of an H-shaped opening 16e, which are to be formed into movable parts 16a, 16b later, protrude both forwardly and rearwardly for a predetermined length. Referring to Fig. 11B, base 16 is subjected to a bending process along two-dot chain lines L1, L2 and others shown in Fig. 11A. Referring to Fig. 12A, piezoelectric/electrostrictive elements 12a, 12b are bonded onto outer sides of movable parts 16a, 16b to form the fifth piezoelectric/electrostrictive device 10e.

[0071] Here, in the fifth piezoelectric/electrostrictive device 10e, reinforcing parts 16f, 16g are bonded to neither fixing part 16c nor mounting part 16d; however, reinforcing parts 16f, 16g are more preferably bonded to fixing part 16c and mounting part 16d. As the bonding means therefor, one can adopt a bonding means such as spot welding, press-bonding, caulking, soldering, brazing, or using an adhesive such as epoxy resin or UV-curing type resin or the like. Among these bonding means, spot welding is especially preferable.

[0072] The fifth piezoelectric/electrostrictive device 10e has the same functions as the first piezoelectric/electrostrictive device 10a and produces approximately similar actions and effects as the first piezoelectric/electrostrictive device 10a. In particular, fixing part 16c and mounting part 16d are reinforced by reinforcing parts 16f, 16g.

[0073] The sixth piezoelectric/electrostrictive device 10f shown in Fig. 1F belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The sixth piezoelectric/electrostrictive device 10f is different from the first piezoelectric/electrostrictive device 10a in that a reinforcing member is added to the base, but the other parts are the same.

[0074] Now, referring to Fig. 14B, the sixth piezoelectric/electrostrictive device 10f is made of a base 17 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 17 is constructed with a pair of right and left long and narrow plate-shaped movable parts 17a, 17b, a flat plate-shaped fixing part 17c that connects the movable parts 17a, 17b with each other at one end thereof, a flat plate-shaped mounting part 17d that connects the movable parts 17a, 17b with each other at the other end thereof, and a plate-shaped reinforcing member 17f inserted between the sides at one ends of movable parts

17a, 17b and bonded to the surface of fixing part 17c. [0075] Referring to Fig. 13A, the original plate 17A of base 17 has the same shape as the original plate 11A of base 11. Referring to Fig. 13B, base 17 is subjected to a bending process along two-dot chain lines L1, L2. Referring to Fig. 14A, reinforcing member 17f is bonded onto the surface of fixing part 17c between the sides at one end of movable parts 17a, 17b, and piezoelectric/electrostrictive elements 12a, 12b are bonded onto outer sides of movable parts 17a, 17b to form the sixth piezoelectric/electrostrictive device 10f. The sixth piezoelectric/electrostrictive device 10f has the same functions as the fourth piezoelectric/electrostrictive device 10d and produces approximately similar actions and effects as the fourth piezoelectric/electrostrictive device 10d.

[0076] The seventh piezoelectric/electrostrictive device 10g shown in Fig. 1G belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The seventh piezoelectric/electrostrictive device 10g is different from the first piezoelectric/electrostrictive device 10a in that the fixing part and the mounting part of the base are differently shaped, but the other parts are the same.

[0077] Now, referring to Fig. 16B, the seventh piezoelectric/electrostrictive device 10g is made of a base 18 and a pair of piezoelectric/electrostrictive elements 12a, 12b. Base 18 is constructed with a pair of right and left long and narrow plate-shaped movable parts 18a, 18b, a flat plate-shaped fixing part 18c that connects the movable parts 18a, 18b with each other at one end thereof, and a flat plate-shaped mounting part 18d that connects the movable parts 18a, 18b with each other at the other end thereof. Fixing part 18c protrudes for a predetermined length from one ends of movable parts 18a, 18b, and mounting part 18d protrudes for a predetermined length from the other ends of movable parts 18a, 18b. Therefore, fixing part 18c and mounting part 18d are an enlargement of fixing part 11c and mounting part 11d in base 11 of the first piezoelectric/electrostrictive device 10a, thereby ensuring a larger area.

[0078] Base 18 is constructed in the same manner as base 11 except that the areas of fixing part 18c and mounting part 18d are enlarged. Further, referring to Fig. 15A, the original plate 18A of base 18 is constructed in such a manner that the front and rear sides of an H-shaped opening 18e, which are to be formed into fixing part 18c and mounting part 18d later, protrude forwardly and rearwardly for a predetermined length. Referring to Fig. 15B, base 18 is subjected to a bending process along two-dot chain lines L1, L2. Referring to Fig. 16A, piezoelectric/electrostrictive elements 12a, 12b are bonded onto outer sides of movable parts 18a, 18b to form the seventh piezoelectric/electrostrictive device 10g.

[0079] The seventh piezoelectric/electrostrictive device 10g has the same functions as the first piezoelectric/electrostrictive device 10a and produces approxi-

mately similar actions and effects as the first piezoelectric/electrostrictive device 10a. In particular, since fixing part 18c and mounting part 18d each have a larger area, the bonding area to the gimbal of the suspension can be enlarged, and the bonding area to the component to be controlled, such as the magnetic head of the hard disk drive, can be enlarged.

[0080] The eighth piezoelectric/electrostrictive device 20a shown in Fig. 1H belongs to the category of the piezoelectric/electrostrictive device of the first form according to the present invention. The eighth piezoelectric/electrostrictive device 20a has a base constructed in a greatly different manner from that of the first piezoelectric/electrostrictive device 10a.

[0081] Now, referring to Fig. 18B, the eighth piezoelectric/electrostrictive device 20a is made of a base 21 and a pair of piezoelectric/electrostrictive elements 22a, 22b. Base 21 is constructed with a pair of right and left long and narrow plate-shaped movable parts 21a, 21b and a flat plate-shaped fixing part 21c that connects the movable parts 21a, 21b with each other at one end thereof. However, a mounting part is not provided on the other ends of movable parts 21a, 21b.

[0082] Referring to Fig. 17A, the original plate 21A of base 21 is formed by subjecting a flat plate to a stamping process, and is provided with a gate-shaped opening 21d. Opening 21d has a shape provided with a pair of straight side grooves 21d1, 21d2 located at right and left sides of the flat plate and extending to the front and rear ends, and an open site 21d3 obtained by cutting and removing the other end located between these two grooves 21d1, 21d2. Base 21 is formed by perpendicularly bending the right and left sides of original plate 21A at the side grooves 21d1, 21d2 along central lines L1, L2 that extend at the center of the width of the grooves 21d1, 21d2 in the longitudinal direction thereof, as shown in Fig. 17B. By bending the right and left sides of original plate 21A in such a manner, the sites located outside the side grooves 21d1, 21d2 are formed into movable parts 21a, 21b, and the site between the side grooves 21d1, 21d2 is formed into fixing part 21c.

[0083] In base 21 thus integrally constructed from original plate 21A, piezoelectric/electrostrictive elements 22a, 22b are bonded via an adhesive onto the outer sides of movable parts 21a, 21b as shown in Fig. 18A to form piezoelectric/electrostrictive device 20a shown in Fig. 18B. Piezoelectric/electrostrictive device 20a thus formed functions in the same manner as the conventional piezoelectric/electrostrictive devices of this form by being used in a state in which a component to be controlled, such as a magnetic head, is bonded between the other ends of movable parts 21a, 21b. However, since base 21 is integrally constructed from one sheet of original plate 21A, piezoelectric/electrostrictive device 20a produces the following functions and effects.

[0084] Namely, in the eighth piezoelectric/electrostrictive device 20a, base 21 has an integral structure

made of original plate 21A and is constructed with one construction component. Therefore, the construction components are two kinds, i.e. base 21 and piezoelectric/electrostrictive elements 22a, 22b, so that the number of construction components of piezoelectric/electrostrictive device 20a can be greatly reduced, and the number of steps for assembling the construction components can be reduced, thereby leading to large reduction of costs.

[0085] Further, in the eighth piezoelectric/electrostrictive device 20a, since the number of construction components is extremely small and the number of bonding sites between the construction components is extremely small, there is little or no variation in the adhesion between the construction components, whereby the eighth piezoelectric/electrostrictive device 20a has device characteristics in which the set precision is high.

[0086] Further, in forming the eighth piezoelectric/electrostrictive device 20a, there is no need to adopt means for cutting a device master at numerous sites as in the prior art, so that there is no contamination caused by adhesion of dusts and other contaminants generated at the time of cutting the device master. For this reason, if base 21 and piezoelectric/electrostrictive elements 22a, 22b are cleaned in advance in assembling the eighth piezoelectric/electrostrictive device 20a, the assembled piezoelectric/electrostrictive device 20a has little or no contamination, thereby providing a great advantage that the step of cleaning the piezoelectric/electrostrictive device 20a can be omitted or carried out in a simple manner.

[0087] The mounting of the component to be controlled and others onto the eighth piezoelectric/electrostrictive device 20a is carried out by fixing them onto the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b via an adhesive. In this case, as will be clear if reference is made to Fig. 19 illustrating a later-mentioned piezoelectric/electrostrictive device 20c which is a modification of the piezoelectric/electrostrictive device 20a, if the height H1 of device 20a is smaller than the height H2 of the component to be controlled, the height H3 in the state in which device 20a and the component to be controlled are assembled will be equal to the height H2 of the component to be controlled (H3 = H2), whereby the height H1 of device 20a can be ignored. This provides an advantage that a further reduction of space can be achieved as compared with the piezoelectric/electrostrictive devices according to other embodiments of the present invention.

[0088] Here, in this assembled structure, since the component to be controlled is sandwiched between the two movable parts 21a, 21b, the interval between the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b must be set substantially equal to the width dimension including the width of the component to be controlled and the thickness of the intervening adhesive layer. If this is neglected, when the interval between the inner surfaces 21a1, 21b1 on the tip end side

of movable parts 21a, 21b is too narrow, the component cannot be placed between the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b, thereby making the assemblage impossible, whereas if

5 the interval between the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b is too wide, the component to be controlled cannot be bonded to both of the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b, thereby making the assemblage impossible.

[0089] Further, if this assembled structure is adopted, even if the interval between the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b is set to be at a width dimension such that the component

15 can be placed and bonded to both of the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b, if the thickness of the adhesive layer for bonding the component to be controlled onto the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a,

20 21b varies, the displacement and the resonance frequency of the two movable parts 21a, 21b is changed, thereby causing variation in the device characteristics. For this reason, in a bending process for forming base

25 21, a press-molding means of high precision is adopted to enable mass production of bases 21 bent in a highly precise manner. This will reduce the variation in the thickness of the adhesive layer for bonding the component onto the inner surfaces 21a1, 21b1 on the tip end side of movable parts 21a, 21b as much as possible,

30 whereby the device will have a quality with extremely reduced variation of device characteristics.

[0090] Fig. 19 illustrates a piezoelectric/electrostrictive device 20c which is a first modification of the eighth piezoelectric/electrostrictive device 20a. The piezoelectric/electrostrictive device 20c has the same basic construction as the piezoelectric/electrostrictive device 20a, and is different in construction from the piezoelectric/electrostrictive device 20a only in that the tip ends of

35 movable parts 21a, 21b are inwardly bent. Namely, movable parts 21a, 21b have bent portions 21a2, 21b2 at the tip ends thereof. The bent portions 21a2, 21b2 are formed by bending the tip ends of movable parts 21a, 21b inwardly by about 180°, and the inside surfaces of the bent portions 21a2, 21b2 face each other to provide

40 45 mounting sites for mounting the component H to be controlled. The component H to be controlled is mounted by being bonded to the inside surfaces of bent portions 21a2, 21b2 via a suitable adhesive.

[0091] Here, since the other parts of piezoelectric/electrostrictive device 20c are the same as those of piezoelectric/electrostrictive device 20a, like constituent members and like constituent sites are denoted with like reference numerals, and their detailed description will be omitted.

[0092] Thus, in the piezoelectric/electrostrictive device 20c, the bonding length and the bonding area to the component H to be controlled can be defined by the two bent portions 21a2, 21b2, thereby effectively eliminating

the variation of the bonding length and the bonding area to the component H to be controlled among individual devices. This can eliminate the variation in the value of displacement and the resonance frequency among individual devices caused by the variation in the bonding length and the bonding area to the component H to be controlled.

[0093] Here, in the piezoelectric/electrostrictive device 20c, as described in the function and effects of the eighth piezoelectric/electrostrictive device 20a, since the height H1 of device 20c is smaller than the height H2 of the component to be controlled, the height H3 in the state in which the component H to be controlled is mounted on device 20c is equal to the height H2 of the component H to be controlled ( $H3 = H2$ ), so that the height H1 of device 20c can be ignored, thereby providing an advantage of further reduction in the space as compared with the piezoelectric/electrostrictive devices according to other embodiments of the present invention.

[0094] Fig. 20 illustrates a piezoelectric/electrostrictive device 20d which is a second modification of the eighth piezoelectric/electrostrictive device 20a. The piezoelectric/electrostrictive device 20d has the same basic construction as the piezoelectric/electrostrictive device 20a, and is different in construction from the piezoelectric/electrostrictive device 20a only in that the movable parts 21a, 21b are formed to be narrow band-shaped plates with steps, and the tip ends of movable parts 21a, 21b constitute crooked portions 21a3, 21b3 that are slightly biased inwardly from the principal part. The crooked portions 21a3, 21b3 of movable parts 21a, 21b are positioned to face each other, and the inside surfaces of these crooked portions 21a3, 21b3 constitute mounting sites for mounting the component H to be controlled, in the same manner as the bent portions 21a2, 21b2 in piezoelectric/electrostrictive device 20c. The component H to be controlled is bonded onto the inside surfaces of crooked portions 21a3, 21b3 via a suitable adhesive. Therefore, the piezoelectric/electrostrictive device 20d functions in the same manner as the piezoelectric/electrostrictive device 20c, and produces the same actions and effects as the piezoelectric/electrostrictive device 20c.

[0095] Here, since the other parts of piezoelectric/electrostrictive device 20d are the same as those of piezoelectric/electrostrictive device 20c, the same constituent members and the same constituent sites as in piezoelectric/electrostrictive device 20c are denoted with the same reference numerals as in piezoelectric/electrostrictive device 20c, and their detailed description will be omitted.

[0096] The ninth piezoelectric/electrostrictive device 20b shown in Fig. 11 belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. The ninth piezoelectric/electrostrictive device 20b has a base constructed in a greatly different manner from that of the first piezoelec-

tric/electrostrictive device 10a.

[0097] Now, referring to Fig. 22B, the ninth piezoelectric/electrostrictive device 20b is made of a base 23 and a pair of piezoelectric/electrostrictive elements 22a, 22b. Base 23 is constructed with a pair of right and left long and narrow plate-shaped movable parts 23a, 23b, a flat and narrow plate-shaped fixing part 23c that connects the movable parts 23a, 23b with each other at one end thereof, and a flat and narrow plate-shaped mounting part 23d that connects the movable parts 23a, 23b with each other at the other end thereof.

[0098] Referring to Fig. 21A, the original plate 23A of base 23 is formed by subjecting a flat plate to a stamping process, and is provided with a generally square-shaped opening 23e. Base 23 is formed by perpendicularly bending the right and left sides of original plate 23A at the opening peripheries of opening 23e along central lines L1, L2 that extend along the opening peripheries in the longitudinal direction, as shown in Fig.

21B. By bending the right and left sides of original plate 23A in such a manner, the sides of the opening peripheries are formed into movable parts 23a, 23b, and the sites between the sides of the opening peripheries are formed into fixing part 23c and mounting part 23d.

[0099] In base 23 thus integrally constructed from original plate 23A, piezoelectric/electrostrictive elements 22a, 22b are bonded via an adhesive onto the outer sides of movable parts 23a, 23b as shown in Fig. 22A to form piezoelectric/electrostrictive device 20b shown in Fig. 22B. The assembled piezoelectric/electrostrictive device 20b functions in the same manner as the conventional piezoelectric/electrostrictive devices of this form. However, since base 23 is integrally constructed from one sheet of original plate 23A, piezoelectric/electrostrictive device 20b produces approximately the same functions and effects as the first piezoelectric/electrostrictive device 10a and the eighth piezoelectric/electrostrictive device 20a.

[0100] In the ninth piezoelectric/electrostrictive device 20b, fixing part 23c and mounting part 23d are small, and the bonding area to the actuator or the component to be controlled is small. However, if one can adopt means for firmly joining the component with a small bonding area, such as spot welding, the ninth piezoelectric/electrostrictive device 20b has no disadvantage. A large fixing part or mounting part acts as a superfluous weight (mass). In this respect, the ninth piezoelectric/electrostrictive device 20b is different from the other piezoelectric/electrostrictive devices 10a to 10g. Since a superfluous mass is absent, the resonance frequency can be set to be high, thereby providing an advantage that the actuator can be operated at a higher speed.

[0101] Regarding the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d according to the above-described embodiments, in the stamped structure adopted as an original plate for forming the bases 11 to 18, 21, and 23, the openings 11e to 18e, 21d, and 23e

are formed by stamping simultaneously at the time of the stamping process. However, these openings 11e to 18e, 21d, and 23e of the original plate can be formed by machining the original plate stamped out into a predetermined shape, using means other than the stamping means, for example, a hole-forming machining means such as laser machining, electric discharge machining, drill machining, ultrasonic machining, or etching. Regarding the hole-forming machining means, if means other than etching is used, burrs may be generated at the edge of the machined hole; however, the burrs can be easily removed by an etching process or a blasting process.

[0102] Further, the movable parts 11a, 11b... constituting the bases 11, 13 to 18, 21, 23 of the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d are preferably bent at an angle of about 90° to the fixing parts 11c... and the mounting parts 11d..., and the intersecting angle is within the range of 90° ± 10°, preferably 90° ± 5°, more preferably 90° ± 1°. If the angle of bending the movable parts 11a, 11b... is deviated from 90°, the displacement in the flapping direction will be large. Here, the above notation ... is used to mean that the reference numerals of the other corresponding sites are omitted, and is used to abbreviate the description.

[0103] The bases 11 to 18, 21, 23 formed by bending are preferably subjected to an ultrasonic cleaning process using a detergent, an organic solvent, or the like. With the use of ultrasonic cleaning, the bases are not destroyed even if the power is increased, so that ultrasonic cleaning with a large power can remove the contamination easily.

[0104] Further, the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d are constructed in such a manner that the base and the piezoelectric/electrostrictive elements are formed as separate bodies, and the piezoelectric/electrostrictive elements are bonded to the movable parts of the base. However, in the piezoelectric/electrostrictive devices according to the present invention, a piezoelectric/electrostrictive layer and electrodes can be formed as films by means of sputtering, CVD, MBE, or the like or formed as films by the sol-gel method onto the portions to become the movable parts in the original plate before being formed into the base, or onto the movable parts of the base, thereby to form the piezoelectric/electrostrictive elements directly on the base.

[0105] The piezoelectric/electrostrictive elements 12a, 12b, 22a, 22b constituting the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d according to the above-described embodiments are each provided with a piezoelectric/electrostrictive layer and a pair of electrodes for applying an electric field thereto, and are piezoelectric/electrostrictive elements of unimorph type, bimorph type, or the like. Among these, piezoelectric/electrostrictive elements of unimorph type are excellent in the stability of the generating displacement, and are also advantageous for weight reduction, so that they are

suitable as a construction component of piezoelectric/electrostrictive devices.

[0106] Figs. 23 and 24 illustrate several examples of piezoelectric/electrostrictive elements 31 to 34 that are 5 suitably adopted as the piezoelectric/electrostrictive elements 12a, 12b, 22a, 22b constituting the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d.

[0107] Piezoelectric/electrostrictive element 31 shown in Fig. 23A has a one-layer structure in which the 10 piezoelectric/electrostrictive layer consists of one layer, and is constructed with a piezoelectric/electrostrictive layer 31a, a pair of lower first and upper second electrodes 31b, 31c, and a pair of terminals 31d, 31e. Piezoelectric/electrostrictive element 32 shown in Fig. 23B 15 has a two-layer structure in which the piezoelectric/electrostrictive layer consists of two layers, and is constructed with piezoelectric/electrostrictive layers 32a, 32b, a first electrode 32c that intervenes between the two piezoelectric/electrostrictive layers 32a, 32b, a second 20 electrode 32d that surrounds the outer sides of the two piezoelectric/electrostrictive layers 32a, 32b, and a pair of terminals 32e, 32f.

[0108] Piezoelectric/electrostrictive elements 33, 34 shown in Fig. 24 each have a four-layer structure in 25 which the piezoelectric/electrostrictive layer consists of four layers. Piezoelectric/electrostrictive element 33 shown in Fig. 24A is constructed with piezoelectric/electrostrictive layers 33a, 33b, 33c, 33d, first and second electrodes 33e, 33f that intervene between and surround the four piezoelectric/electrostrictive layers 33a, 33b, 33c, 33d, and a pair of terminals 33g, 33h. The piezoelectric/electrostrictive element 34 shown in Fig. 24B is different from the piezoelectric/electrostrictive element 33 in that the terminals are placed at different 30 sites. Piezoelectric/electrostrictive element 34 is constructed with piezoelectric/electrostrictive layers 34a, 34b, 34c, 34d, first and second electrodes 34e, 34f that intervene between and surround the four piezoelectric/electrostrictive layers 34a, 34b, 34c, 34d, and a pair of terminals 34g, 34h.

[0109] These piezoelectric/electrostrictive elements 31 to 34 are suitably adopted as the piezoelectric/electrostrictive elements 12a, 12b, 22a, 22b of the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d in 45 accordance with the usage of the piezoelectric/electrostrictive devices.

[0110] In addition to piezoelectric ceramic, one can 50 use electrostrictive ceramic, ferroelectric ceramic, anti-ferroelectric ceramic, or the like as well in the piezoelectric/electrostrictive layers constituting the piezoelectric/electrostrictive elements 31 to 34. However, if the piezoelectric/electrostrictive device is used for positioning the magnetic head of a hard disk drive or the like purpose, it is preferable to use a material whose striction (distortion) hysteresis is small because the linearity between the displacement amount of the mounting part and the driving voltage or the output voltage is essential. It is preferable to use a material having a coercive elec- 55

tric field of at most 10 kV/mm.

[0111] As a material for forming the piezoelectric/electrostrictive layers, one can specifically mention lead zirconate, lead titanate, magnesium lead niobate, zinc lead niobate, manganese lead niobate, antimony lead stannate, manganese lead tungstate, cobalt lead niobate, barium titanate, bismuth sodium titanate, potassium sodium niobate, strontium bismuth tantalate, and others, which are used either alone or as a suitable mixture thereof. Particularly, a material containing lead zirconate, lead titanate, or magnesium lead niobate as a major component, or a material containing bismuth sodium titanate as a major component is suitable.

[0112] The characteristics of the piezoelectric/electrostrictive layers can be adjusted by adding a suitable material to the materials for forming the piezoelectric/electrostrictive layers. As a material to be added, one can mention oxides of lanthanum, calcium, strontium, molybdenum, tungsten, barium, niobium, zinc, nickel, manganese, cesium, cadmium, chromium, cobalt, antimony, iron, yttrium, tantalum, lithium, bismuth, tin, and others, or materials that eventually become oxides, which are used either alone or as a suitable mixture thereof.

[0113] For example, by allowing lanthanum or strontium to be contained in lead zirconate, lead titanate, magnesium lead niobate, or the like constituting the major component, there will be provided an advantage that the coercive electric field or the piezoelectric property can be adjusted. Here, it is preferable to avoid addition of a material that easily undergoes vitrification, such as silica. This is because a material such as silica that easily undergoes vitrification is liable to react with the piezoelectric/electrostrictive layers at the time of thermal treatment of the piezoelectric/electrostrictive layers, and changes their composition to deteriorate the piezoelectric properties.

[0114] The electrodes constituting the piezoelectric/electrostrictive elements 31 to 34 are preferably made of a metal material that is solid at room temperature and excellent in electrical conductivity. As a metal material, one can mention metals such as aluminum, titanium, chromium, iron, cobalt, nickel, copper, zinc, niobium, molybdenum, ruthenium, palladium, rhodium, silver, tin, tantalum, tungsten, iridium, platinum, gold, or lead, which are used as a single metal or an alloy of these metals. Further, one can use a thermet material obtained by dispersing ceramics made of the same materials as or made of different materials from the piezoelectric/electrostrictive layers into these metal materials.

[0115] Piezoelectric/electrostrictive elements 31 to 34 are preferably formed by integrally baking the piezoelectric/electrostrictive layers and the electrodes in a mutually laminated state. In this case, as the electrodes, it is preferable to adopt those made of a high-melting-point metal material such as platinum, palladium, or an alloy of these, or an electrode made of a thermet material which is a mixture of a high-melting-point metal ma-

terial and the materials for forming the piezoelectric/electrostrictive layers or other ceramic materials. The thickness of the electrodes preferably has a film shape as thin as possible because the thickness becomes a

5 factor that affects the displacement of the piezoelectric/electrostrictive elements. For this reason, in order that the electrodes formed by being integrally baked with the piezoelectric/electrostrictive layers have a film shape as thin as possible, it is preferable to use the material for 10 forming the electrodes in a form of a metal paste, for example, a gold resinate paste, platinum resinate paste, silver resinate paste, or the like.

[0116] The thickness of each of the piezoelectric/electrostrictive elements 31 to 34 is preferably within a range

15 from 40  $\mu\text{m}$  to 180  $\mu\text{m}$  if piezoelectric/electrostrictive elements 31 to 34 are to be used as the piezoelectric/electrostrictive elements 12a, 12b, 22a, 22b of the piezoelectric/electrostrictive device according to each embodiment. If the thickness is below 40  $\mu\text{m}$ , piezoelectric/electrostrictive elements 31 to 34 are liable to be broken

20 during the handling, whereas if the thickness exceeds 180  $\mu\text{m}$ , the scale reduction of the device will be difficult. Further, by allowing the piezoelectric/electrostrictive elements to have a multi-layer structure such as in the

25 piezoelectric/electrostrictive elements 33, 34, one can increase the output of the piezoelectric/electrostrictive elements to enlarge the displacement of the device. Furthermore, by allowing the piezoelectric/electrostrictive elements to have a multi-layer structure, the rigidity of 30 the device will be improved, thereby advantageously raising the resonance frequency of the device to increase the speed of the displacement operation of the device.

[0117] Piezoelectric/electrostrictive elements 31 to 34 35 are prepared using means for cutting an original plate of a large area, which is formed by laminating and baking the piezoelectric/electrostrictive layers and the electrodes by printing or tape molding, out into a predetermined dimension in a large number with the use of a

40 dicing machine, a slicer, a wire-saw, or the like. Piezoelectric/electrostrictive elements 31 to 34 are thinner and have a lower hardness than known ceramic bases, so that the speed of cutting the original plate can be set to be high, whereby the original plates can be processed 45 in a large mass and at a high speed.

[0118] Piezoelectric/electrostrictive elements 31 to 34 50 have a simple plate-shaped structure and can be easily handled with. Also, since the surface area is small, the amount of adhering dust is small, and the dust can be easily removed. However, since the piezoelectric/electrostrictive elements are mainly made of a ceramic material, a suitable cleaning condition must be set in ultrasonic cleaning. In a piezoelectric/electrostrictive element cut out from the original plate, it is preferable to

55 perform a precision cleaning treatment by US cleaning and then perform a heat treatment at 100°C to 1000°C in atmospheric air so as to completely remove the moisture and organic substances that have penetrated into

fine pores of the ceramic material.

[0119] If the piezoelectric/electrostrictive elements 31 to 34 are to be adopted as the piezoelectric/electrostrictive elements 12a, 12b, 22a, 22b constituting the piezoelectric/electrostrictive devices 10a to 10g, 20a to 20d according to each embodiment, it is preferable to use a resin-series adhesive such as epoxy resin, UV resin, or hot-melt adhesive, or an inorganic adhesive such as glass, cement, solder, or brazing material as a bonding means to the base of each of the piezoelectric/electrostrictive elements 31 to 34. Also, a mixture of resin-series adhesive with metal powder or ceramic powder can be used as well. The hardness of the adhesive is preferably not less than 80 in terms of Shore D hardness.

[0120] Here, it is preferable to perform a surface roughening treatment such as blasting, etching, or plating on the surface site of the base where the piezoelectric/electrostrictive element is to be bonded. By allowing the surface roughness of the bonding site to be  $R_a$  = about  $0.1 \mu\text{m}$  to  $5 \mu\text{m}$ , the bonding area can be enlarged to improve the adhesive strength. In this case, the surface of the bonding site on the piezoelectric/electrostrictive element side is preferably rough as well. If one wishes that the electrodes are not electrically conducted to the base, the electrodes are not disposed on the surface of the piezoelectric/electrostrictive layer constituting the lowermost layer.

[0121] If solder or brazing material is to be used as the adhesive, it is preferable to dispose an electrode layer made of a metal material on the surface of the piezoelectric/electrostrictive element in order to improve the wettability. The thickness of the adhesive is preferably within the range from  $1 \mu\text{m}$  to  $50 \mu\text{m}$ . The thickness of the adhesive is preferably small in view of reducing variations in the displacement and in the resonance characteristics of the device and in view of saving space; however, in order to ensure the characteristics such as the bonding strength, displacement, and resonance frequency, the optimal thickness is set for each adhesive to be adopted.

[0122] In bonding the piezoelectric/electrostrictive element to the base, the piezoelectric/electrostrictive element is bonded to the base so that the piezoelectric/electrostrictive element completely overlaps the bending position of the fixing part while allowing the electrodes of the piezoelectric/electrostrictive element to be on the side of the fixing part of the base. The piezoelectric/electrostrictive element is preferably bonded so as to align with the end of the base on the fixing part side; however, in order to facilitate the connection between the terminals of the piezoelectric/electrostrictive element and the external terminals, one may bond the piezoelectric/electrostrictive element to protrude outward from the end of the base. However, since the piezoelectric/electrostrictive element is liable to be broken as compared with the base which is made of metal, one must take care in handling the piezoelectric/electrostrictive element.

[0123] Fig. 25 illustrates an example in which the piezoelectric/electrostrictive element 34 is adopted as the piezoelectric/electrostrictive elements 12a, 12b in the first piezoelectric/electrostrictive device 10a that belongs to the category of the piezoelectric/electrostrictive device of the second form according to the present invention. Hereafter, the first piezoelectric/electrostrictive device 10a of this embodiment will be used as a representative example having a basic construction of the piezoelectric/electrostrictive device according to the present invention. The construction and operation as well as functions and effects of the piezoelectric/electrostrictive device according to the present invention will be described in detail with reference to the first piezoelectric/electrostrictive device 10a.

[0124] If a part of piezoelectric/electrostrictive element 34 is positioned at the fixing part 11c of the base 11 in the piezoelectric/electrostrictive device 10a,  $(1 - L_b/L_a)$  is preferably at least 0.4, more preferably from 0.5 to 0.8, where  $L_a$  is the shortest distance between the boundary to the mounting part 11d and the boundary to the fixing part 11c in the pair of movable parts 11a, 11b, and  $L_b$  is the shorter one of the distances from the boundary part between the mounting part 11d and the movable parts 11a, 11b to either end of the electrodes 34e, 34f of the piezoelectric/electrostrictive element 34, as illustrated in Fig. 26. If this value is less than 0.4, one cannot obtain a large displacement of the device. If this value is within a range from 0.5 to 0.8, compatibility between the displacement and the resonance frequency of the device can be more easily achieved. In this case, one can adopt a construction in which the piezoelectric/electrostrictive element 34 is bonded to only one of the movable parts 11a, 11b, thereby providing a more preferable embodiment. Here, the same applies to the case in which a part of the piezoelectric/electrostrictive element 34 is positioned at a part of the mounting part 11d.

[0125] In the piezoelectric/electrostrictive device 10a, application of voltage to the electrodes 34e, 34f of the two piezoelectric/electrostrictive elements 34 is carried out through terminals 34g, 34h. The terminals 34g, 34h are positioned in such a manner that the terminal 34g to one electrode 34e is formed toward the rear of fixing part 11c, and the terminal 34h to the other electrode 34f is formed toward the front direction of fixing part 11c. Either one of the terminals 34g, 34h can be omitted by being electrically conducted to base 11 to be grounded commonly with base 11. The width of the piezoelectric/electrostrictive element 34 to be bonded need not be the same as the width of the bonding site of base 11 (bonding site of movable parts 11, 11b), and the difference in width does not raise any problem in the functions of the device.

[0126] Piezoelectric/electrostrictive device 10a is formed, for example, to have a total length of 1.9 mm and a total width of 1.5 mm by forming base 11 with SUS304 having a plate thickness of  $40 \mu\text{m}$ . Piezoelectric/electrostrictive element 34 adopted as piezoelectric/

electrostrictive elements 12a, 12b is a four-layer structure in which PZT is used. The thickness of one layer of the piezoelectric/electrostrictive layers 34a to 34d is 15  $\mu\text{m}$ . The electrodes 34e, 34f are made of platinum of 3  $\mu\text{m}$ , and terminals 34g, 34h are thin films made of gold paste. The piezoelectric/electrostrictive elements 34 are bonded onto outer sides of movable parts 11a, 11b via a one-liquid thermosetting epoxy resin adhesive.

[0127] In the piezoelectric/electrostrictive device 10a thus constructed to have such a size, the displacement of mounting part 11d was measured when the piezoelectric/electrostrictive element 34 was driven by a sinusoidal wave of 1 kHz with a driving voltage of  $20 \pm 20\text{V}$ . The displacement was found to be  $\pm 1.5 \mu\text{m}$ . Further, the resonance frequency showing the maximum value of the displacement was measured by sweeping the frequency at sinusoidal wave voltage  $\pm 0.5 \text{ V}$ , and was found out to be 45 kHz.

[0128] Next, the operation of the piezoelectric/electrostrictive device according to the present invention will be described with reference to the above-described first piezoelectric/electrostrictive device 10a.

[0129] The piezoelectric/electrostrictive device 10a is in a state shown in Fig. 26 at the time of non-operation when a voltage is not applied to piezoelectric/electrostrictive elements 12a, 12b. In this state, the longitudinal axis m (longitudinal axis of fixing part 11c) of piezoelectric/electrostrictive device 10a is almost coincident with the central axis n of mounting part 11d. In this state, a sinusoidal wave Wb having a predetermined bias voltage Vb is applied to the pair of electrodes 34e, 34f in one piezoelectric/electrostrictive element 12b, for example, as shown in the waveform diagram of Fig. 27A, and a sinusoidal wave Wa having a phase different by approximately 180° from that of the aforesaid sinusoidal wave Wb is applied to the pair of electrodes 34e, 34f in the other piezoelectric/electrostrictive element 12a, for example, as shown in Fig. 27B.

[0130] Now, at the stage when for example the maximum voltage is applied to the pair of electrodes 34e, 34f in the one piezoelectric/electrostrictive element 12b, the piezoelectric/electrostrictive layers 34a to 34d in the one piezoelectric/electrostrictive element 12b undergo shrinking displacement in the principal surface direction thereof.

[0131] This generates a stress that warps one movable part 11b in the illustrated right direction (direction shown by arrow A) in piezoelectric/electrostrictive device 10a, for example, as shown in Fig. 28. By this stress, movable part 11b is warped in that direction. In this case, the pair of electrodes 34e, 34f in the other piezoelectric/electrostrictive element 12a are in a state in which a voltage is not applied. Therefore, the other movable part 11a follows the warp of the one movable part 11b so as to warp in the same direction as that of movable part 11b. As a result of this, movable parts 11a, 11b both displace in the illustrated right direction with respect to the longitudinal axis m of piezoelectric/electrostrictive device 10a. The displacement amount of this displacement changes in accordance with the maximum value of the voltage applied to each of the piezoelectric/electrostrictive elements 12a, 12b. The larger the maximum value of the voltage is, the larger the displacement amount will be.

[0132] In particular, if a piezoelectric/electrostrictive material having a high coercive electric field is adopted as a material for constructing the piezoelectric/electrostrictive layers 34a to 34d constituting the piezoelectric/electrostrictive element 34, the aforesaid bias voltage may be adjusted so that the minimum level will be at a slightly negative level, as illustrated by waveforms drawn in two-dot chain lines in Figs. 27A and 27B. In this case, by driving the piezoelectric/electrostrictive element to which the bias voltage of negative level is applied, for example, by driving the other piezoelectric/electrostrictive element 12a, for example, a stress is generated in the other movable part 11a in the same direction as the warping direction of the one movable part 11b, thereby providing a larger displacement amount of mounting part 11d. In other words, by using the waveforms shown in two-dot chain lines in Figs. 27A and 27B, the piezoelectric/electrostrictive elements 12a, 12b to which the bias voltage of negative level is applied can have a function of supporting the piezoelectric/electrostrictive element 12b, 12a acting as a main agent of displacement operation.

[0133] Thus, in piezoelectric/electrostrictive device 10a, a minute displacement of piezoelectric/electrostrictive elements 12a, 12b is amplified to become a large displacement operation by utilizing the warp of movable parts 11a, 11b, and is transmitted to movable parts 11a, 11b. This makes it possible to displace the mounting part 11d to a large extent with respect to the longitudinal axis m of piezoelectric/electrostrictive device 10a.

[0134] In the piezoelectric/electrostrictive device 10a, it is preferable to give the following consideration so as to allow the functions thereof to be exhibited with more certainty. Namely, in order to ensure the displacement operation of mounting part 11d, the distance Ld by which the substantial driving part Lc of piezoelectric/electrostrictive elements 12a, 12b overlaps the fixing part 11c or mounting part 11d is preferably not less than a half of the thickness b of movable parts 11a, 11b. Further, the device is constructed in such a manner that the ratio c/d of the distance c between the inner walls of movable parts 11a, 11b (distance in the X-axis direction) to the width d of movable parts 11a, 11b (distance in the Y-axis direction) is from 0.5 to 20. The ratio c/d is preferably from 1 to 15, more preferably from 1 to 10. The defined values of the ratio c/d are based on the knowledge that the displacement amount of mounting part 11d can be increased and the displacement in the X-axis-Z-axis plane can be dominantly obtained.

[0135] The ratio e/c of the substantial movable length e in movable parts 11a, 11b having a total length of e0 to the distance c between the inner walls of movable parts 11a, 11b is

parts 11a, 11b is preferably from 0.5 to 10, more preferably from 0.5 to 5. The length f1 of the connecting part between the mounting part 11d and the movable parts 11a, 11b (distance in the Z-axis direction) and the length f2 of the connecting part between the fixing part 11c and the movable parts 11a, 11b (distance in the Z-axis direction) are preferably short. By providing a short mounting part 11d, the device can have a reduced weight, and the resonance frequency can be increased. However, in order to ensure the rigidity of mounting part 11d in the X-axis direction to make a firm displacement, the ratios f1/b and f2/b to the thickness b of movable parts 11a, 11b is preferably at least 2, more preferably at least 5. Further, the distance e1x from the bending position L1 of base 11 to fixing part 11c or mounting part 11d and the distance e1y from L1 to movable part 11a preferably satisfy  $(e1x/b) > 1$  and  $(e1y/b) > 1$ , more preferably  $(e1x/b) \geq 2$  and  $(e1y/b) \geq 2$ .

[0136] It is essential to set the real dimension of the parts of the piezoelectric/electrostrictive device 10a in consideration of the bonding area of mounting part 11d for mounting the component, the bonding area for mounting the fixing part 11c to another member, the bonding area for mounting the terminals for the electrodes and others, the strength of the whole device, the durability, the necessary displacement amount and resonance property, the driving voltage, and others.

[0137] Specifically, for example, the distance c between the inner walls of movable parts 11a, 11b is preferably from 100  $\mu\text{m}$  to 2000  $\mu\text{m}$ , more preferably from 200  $\mu\text{m}$  to 1600  $\mu\text{m}$ . The width d of movable parts 11a, 11b is preferably from 50  $\mu\text{m}$  to 2000  $\mu\text{m}$ , more preferably from 100  $\mu\text{m}$  to 500  $\mu\text{m}$ . In order that the flapping displacement, which is a displacement component in the Y-axis direction, may be effectively restrained, the thickness b of movable parts 11a, 11b and the width d of movable parts 11a, 11b satisfy  $d > b$ , and the thickness b is preferably from 2  $\mu\text{m}$  to 300  $\mu\text{m}$ , more preferably from 10  $\mu\text{m}$  to 80  $\mu\text{m}$ .

[0138] The substantial movable length e in movable parts 11a, 11b is preferably from 200  $\mu\text{m}$  to 3000  $\mu\text{m}$ , more preferably from 300  $\mu\text{m}$  to 2000  $\mu\text{m}$ . The connecting length f1 between mounting part 11d and movable parts 11a, 11b and the connecting length f2 between fixing part 11c and movable parts 11a, 11b are preferably from 50  $\mu\text{m}$  to 2000  $\mu\text{m}$ , more preferably from 100  $\mu\text{m}$  to 1000  $\mu\text{m}$ .

[0139] The distance e1x from the bending position L1 of base 11 to fixing part 11c or mounting part 11d is preferably from 1  $\mu\text{m}$  to 300  $\mu\text{m}$ , more preferably from 5  $\mu\text{m}$  to 80  $\mu\text{m}$ . Further, the distance e1y from the bending position L1 of base 11 to movable part 11a is preferably from 1  $\mu\text{m}$  to 1000  $\mu\text{m}$ , more preferably from 5  $\mu\text{m}$  to 500  $\mu\text{m}$ . Here, the distance from the bending position L2 of base 11 to fixing part 11c or mounting part 11d (distance corresponding to distance e1x) and the distance from the bending position L2 of base 11 to movable part 11a (distance corresponding to distance e1y) are

similar to distance e1x and distance e1y.

[0140] By constructing the piezoelectric/electrostrictive device 10a in such a manner, the displacement in the Y-axis direction can be prevented from exceeding 5 10% of the displacement in the X-axis direction. However, by suitably setting the dimension ratios and the real dimensions within the aforesaid ranges, the device can be driven at a low voltage, and it produces an excellent effect that the displacement in the Y-axis direction 10 can be restrained to be not more than 5% of the displacement in the X-axis direction. In other words, mounting part 11d displaces substantially in one axial direction, i.e. the X-axis direction, thereby providing an excellent property that the high-speed response is 15 excellent and a large displacement is obtained at a low voltage.

[0141] Further, in the piezoelectric/electrostrictive device 10a, base 11 constituting the principal construction component has a specific shape, and the movable parts 20 11a, 11b are approximately perpendicular to fixing part 11c and mounting part 11d to function as ribs, so that the rigidity of the device in the Y-axis direction can be set high. For this reason, in the piezoelectric/electrostrictive device 10a, the operation of mounting part 11d 25 can be selectively generated in a plane (in X-axis-Z-axis plane) alone, and the operation of mounting part 11d in the Y-axis-Z-axis plane, i.e. operation in the so-called flapping direction, can be restrained.

[0142] Here, in the device according to the present invention, by devising the shapes of the fixing part and the mounting part of the base, the gimbal of the suspension of the hard disk drive can be integrated with the base of the device.

[0143] Here, Figs. 29 and 30 illustrate two modifications 35 of the first piezoelectric/electrostrictive device 10a. The piezoelectric/electrostrictive devices 10a1, 10a2 according to these modifications have basically the same construction as the first piezoelectric/electrostrictive device 10a. However, in the piezoelectric/electrostrictive device 10a1, circular recesses 11c1, 11d1 are formed by press-molding generally at the central parts 40 of fixing part 11c and mounting part 11d of base 11. In the piezoelectric/electrostrictive device 10a2, circular through-holes 11c2, 11d2 are formed by stamping generally at the central parts of fixing part 11c and mounting part 11d of base 11.

[0144] In piezoelectric/electrostrictive device 10a1, circular recesses 11c1, 11d1 disposed in the fixing part 50 11c and mounting part 11d of base 11 serve to accommodate an adhesive for bonding the component to be mounted to fixing part 11c and mounting part 11d, whereby the adhesive accommodated in the recesses 11c1, 11d1 increases the bonding strength to the component and the squeeze-out of the adhesive from the bonding site can be prevented.

[0145] Further, in piezoelectric/electrostrictive device 10a2, circular through-holes 11c2, 11d2 disposed in the fixing part 55 11c and mounting part 11d of base 11 act as

a standard for positioning in assembling (bonding) the component onto fixing part 11c and mounting part 11d, whereby the precision of assembling in later steps can be improved, and the yield of the products can be improved.

[0146] The tenth piezoelectric/electrostrictive device 20e and the eleventh piezoelectric/electrostrictive device 20f shown in Figs. 1J and 1K are piezoelectric/electrostrictive devices belonging to the category of the piezoelectric/electrostrictive device of the third form according to the present invention. Referring to Figs. 31 and 32, these piezoelectric/electrostrictive devices 20e, 20f each have a basic construction including a base having a pair of right and left movable parts, a fixing part that connects the two movable parts with each other at one end thereof, a mounting part that is separate from the fixing part and connects the two movable parts with each other at the other end thereof, and a connecting part that is integral with the mounting part and surrounds the mounting part, the movable parts, and the fixing part, as well as a piezoelectric/electrostrictive element disposed on at least one side of the two movable parts of the base. The piezoelectric/electrostrictive devices 20e, 20f are largely different in the construction of the base from the piezoelectric/electrostrictive devices of the other embodiments.

[0147] The base 24 constituting the tenth piezoelectric/electrostrictive device 20e shown in Fig. 31 includes a pair of right and left movable parts 24a, 24b, a fixing part 24c that connects the two movable parts 24a, 24b with each other at one end thereof, a mounting part 24d that connects the two movable parts 24a, 24b with each other at the other end thereof, and a connecting part 24e that is integral with the mounting part 24d.

[0148] The base 24 has such a configuration that a connecting part is added to the base 18 constituting the seventh piezoelectric/electrostrictive device 10g. The connecting part 24e of base 24 has a flat plate shape having a square-shaped opening 24f1 at the central part thereof, where movable parts 24a, 24b, fixing part 24c, and mounting part 24d are placed in an integral state in the opening 24f1. The connecting part 24e surrounds the principal construction parts of base 24, and the two side peripheries 24e1, 24e2 of connecting part 24e have a spring function.

[0149] Referring to Fig. 32A, the original plate 24A of base 24 has a rectangular opening 24f1 that will constitute the connecting part 24e and a gate-shaped opening 24f2 that will integrally constitute the movable parts 24a, 24b, fixing part 24c, and mounting part 24d. Base 24 shown in Fig. 32B is formed by bending the original plate 24A along two-dot chain lines L1, L2 shown in Fig. 32A. In the base 24 thus formed, piezoelectric/electrostrictive elements 22a, 22b are bonded onto the outer sides of movable parts 24a, 24b to form the tenth piezoelectric/electrostrictive device 20e shown in Fig. 31.

[0150] The tenth piezoelectric/electrostrictive device 20e has the same function as the seventh piezoelectric/

electrostrictive device 10g and produces approximately the same actions and effects as the seventh piezoelectric/electrostrictive device 10g. However, since the tenth piezoelectric/electrostrictive device 20e in particular integrally includes the connecting part 24e having a spring function, the connecting part 24e can be allowed to function as a gimbal of the suspension constituting the hard disk drive. In other words, the base 24 has a function of a gimbal as well.

5 [0151] The base 25 constituting the eleventh piezoelectric/electrostrictive device 20f shown in Fig. 33 includes a pair of right and left movable parts 25a, 25b, a fixing part 25c that connects the two movable parts 25a, 25b with each other at one end thereof, a mounting part 10 25d that connects the two movable parts 25a, 25b with each other at the other end thereof, and a connecting part 25e that is integral with the mounting part 25d.

15 [0152] The base 25 has such a configuration that a connecting part is added to the base 18 constituting the seventh piezoelectric/electrostrictive device 10g. The connecting part 25e of base 25 has a flat plate shape having a gate-shaped opening 25f1 at the central part thereof and having a rectangular opening 25f2, whose one end is open, on the tip end side thereof, where movable parts 25a, 25b, fixing part 25c, and mounting part 25d are placed in an integral state in the opening 25f2. The connecting part 25e surrounds the principal construction parts of base 25, and the two side peripheries 25e1, 25e2 outside the connecting part 25e as well as the two side peripheries 25e3, 25e4 inside the connecting part 25e have a spring function.

20 [0153] Referring to Fig. 34A, the original plate 25A of base 25 has a gate-shaped opening 25f1 and a rectangular opening 25f2 that will constitute the connecting part 25e and a gate-shaped opening 25f3 that will integrally constitute the movable parts 25a, 25b, fixing part 25c, and mounting part 25d. Base 25 shown in Fig. 34B is formed by bending the original plate 25A along two-dot chain lines L1, L2 shown in Fig. 34A. In the base 25 thus formed, piezoelectric/electrostrictive elements 22a, 22b are bonded onto the outer sides of movable parts 25a, 25b to form the eleventh piezoelectric/electrostrictive device 20f shown in Fig. 33.

25 [0154] The eleventh piezoelectric/electrostrictive device 20f has the same function as the seventh piezoelectric/electrostrictive device 10g and produces approximately the same actions and effects as the seventh piezoelectric/electrostrictive device 10g. However, since the eleventh piezoelectric/electrostrictive device 20f in particular integrally includes the connecting part 25e having a spring function, the connecting part 25e can be allowed to function as a gimbal of the suspension constituting the hard disk drive. In other words, the base 25 has a function of a gimbal as well. Furthermore, since the eleventh piezoelectric/electrostrictive device 20f has a higher spring function than the tenth piezoelectric/electrostrictive device 20e, the function of a gimbal can be exhibited with more certainty.

[0155] Fig. 35 illustrates a hard disk drive 40 having the eleventh piezoelectric/electrostrictive device 20f, which is a piezoelectric/electrostrictive device of the third form according to the present invention, mounted thereon. The hard disk drive 40 is a known one provided with a suspension. Base 41 has a voice coil 43 and a magnet 42 mounted thereon, and the suspension 45 having the eleventh piezoelectric/electrostrictive device 20f mounted thereon is attached to an arm 44 disposed on the base 41. Here, the reference numeral 46 denotes a magnetic disk.

[0156] Now, referring to Fig. 36, the eleventh piezoelectric/electrostrictive device 20f has a magnetic head 47 (slider) fixed onto the mounting part 25d of the base 25 via an adhesive, and is fixed by means of spot welding or the like to the rear side of the suspension 45 on the rear side of the connecting part 25e of the base 25. In such a mounting structure of the eleventh piezoelectric/electrostrictive device 20f, the connecting part 25e of the base 25 has a function of a conventional gimbal, thereby providing an advantage that the use of a conventional gimbal can be omitted in mounting the eleventh piezoelectric/electrostrictive device 20f onto the suspension 45.

[0157] While the invention has been shown and described in detail, the foregoing description is in all aspects illustrative and not restrictive. It is therefore understood that numerous other modifications and variations can be devised without departing from the scope of the invention.

## Claims

1. A piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts and a fixing part that connects the two movable parts with each other at one end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said base is constructed with one sheet of flat plate; said fixing part has a flat plate shape; and said movable parts are erect by a predetermined height from side peripheries of said fixing part to face each other and extend beyond the other end of said fixing part along the side peripheries of said fixing part.
2. The piezoelectric/electrostrictive device according to claim 1, wherein a slit-shaped groove extending from the other end of said fixing part intervenes between a base part of the movable parts constituting said base and the side peripheries of said fixing part.
3. A piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts, a fixing part that connects the two movable parts with each other at one end thereof, and a mounting part that is separate from said fixing part and connects the two movable parts with each other at the other end thereof, and a connecting part that is integral with said mounting part and surrounds said mounting part, said movable parts, and said fixing part as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said base is constructed with one sheet of flat plate; said fixing part and said mounting part have a flat plate shape; said movable parts are erect by a predetermined height from side peripheries of said fixing part and said mounting part to face each other and extend along the side peripheries of said fixing part and said mounting part; and said movable parts, said fixing part, and said mounting part are positioned within a central space of said connecting part.
4. The piezoelectric/electrostrictive device according to claim 3, wherein a laterally extending slit-shaped groove intervenes between the other end of said fixing part and the one end of said mounting part constituting said base, and a longitudinally extending slit-shaped groove intervenes between a base part of said movable parts and the side peripheries of said fixing part and said mounting part.
5. The piezoelectric/electrostrictive device according to claim 3, wherein a laterally and longitudinally extending rectangular opening intervenes between the other end of said fixing part and the one end of said mounting part constituting said base.
6. A piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts, a fixing part that connects the two movable parts with each other at one end thereof, a mounting part that is separate from said fixing part and connects the two movable parts with each other at the other end thereof, and a connecting part that is integral with said mounting part and surrounds said mounting part, said movable parts, and said fixing part as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said base is constructed with one sheet of flat plate; said fixing part and said mounting part have a flat plate shape; said movable parts are erect by a predetermined height from side peripheries of said fixing part and said mounting part to face each other and extend along the side peripheries of said fixing part and said mounting part; and said movable parts, said fixing part, and said mounting part are positioned within a central space of said connecting part.
7. The piezoelectric/electrostrictive device according to claim 6, wherein said central space of said connecting part on a side of the one end of said fixing part is closed.
8. The piezoelectric/electrostrictive device according to claim 6, wherein said central space of said con-

with each other at one end thereof, and a mounting part that is separate from said fixing part and connects the two movable parts with each other at the other end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said base is constructed with one sheet of flat plate; said fixing part and said mounting part have a flat plate shape; and said movable parts are erect by a predetermined height from side peripheries of said fixing part and said mounting part to face each other and extend along the side peripheries of said fixing part and said mounting part.

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necting part on a side of the one end of said fixing part is open.

9. The piezoelectric/electrostrictive device according to claim 1 or 2, wherein a connecting portion between a base part of said movable parts and the side peripheries of said fixing part constituting said base has a circular arc shape.

10. The piezoelectric/electrostrictive device according to claim 3, 4, 5, 6, 7 or 8, wherein a connecting portion between a base part of said movable parts and the side peripheries of said fixing part and said mounting part constituting said base has a circular arc shape.

11. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, or 10, wherein a central portion, as viewed in a length direction, of said movable parts constituting said base is formed to have a smaller thickness than other portions of said movable parts.

12. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, or 11, wherein said movable parts constituting said base has a reinforcing part located at an end thereof on said fixing part side and bent from an upper edge of said end to extend towards and abut against a surface of said fixing part.

13. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, or 11, wherein said movable parts constituting said base has a reinforcing part located at an end thereof on said fixing part side and bent from a front edge of said end to extend towards an inner side and abut against a surface of said fixing part.

14. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, or 11, wherein a reinforcing member intervenes between said movable parts on said fixing part constituting said base.

15. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, or 14, wherein said fixing part constituting said base extends from the one end side of said movable parts and is enlarged as compared with a case of being located within said movable parts.

16. The piezoelectric/electrostrictive device according to claim 3, 4, 5, 6, 7, 8, or 10 wherein said mounting part constituting said base extends from the other end side of said movable parts and is enlarged as compared with a case of being located within said movable parts.

17. The piezoelectric/electrostrictive device according to claim 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, or 16 wherein said base is constructed with a flat plate made of metal.

18. A method of producing a piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts and a fixing part that connects the two movable parts with each other at one end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said method comprises the steps of preparing a flexible and bendable flat plate as a material for forming said base, stamping said flat plate into a shape that delineates a plane development of said base to form a stamped structure, and bending said stamped structure at a predetermined site to form the base having said movable parts and said fixing part.

19. The method of producing a piezoelectric/electrostrictive device according to claim 18, wherein said stamped structure has a gate-shaped opening composed of a pair of straight side grooves located at right and left sides of a rectangular flat plate and extending along side peripheries and an opening formed by cutting and removing a portion between the two grooves, and the side peripheries of said flat plate are bent along said side grooves to form said side peripheries into said movable parts and to form a portion between said side grooves into said fixing part.

20. A method of producing a piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts, a fixing part that connects the two movable parts with each other at one end thereof, and a mounting part that is separate from said fixing part and connects the two movable parts with each other at the other end thereof as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said method comprises the steps of preparing a flexible and bendable flat plate as a material for forming said base, stamping said flat plate into a shape that delineates a planar development of said base to form a stamped structure, and bending said stamped structure at a predetermined site to form the base having said movable parts, said fixing part, and said mounting part.

21. The method of producing a piezoelectric/electrostrictive device according to claim 20, wherein said stamped structure has an H-shaped opening composed of a pair of straight side grooves located at right and left sides of a rectangular flat plate and extending along side peripheries and a straight central groove that connects the two side grooves with

each other at a middle part, and the side peripheries of said flat plate are bent along said side grooves to form said side peripheries into said movable parts and to form a portion between said side grooves into said fixing part and said mounting part. 5

22. The method of producing a piezoelectric/electrostrictive device according to claim 20, wherein said stamped structure has a rectangular opening at a central part of a rectangular flat plate, and side peripheries of said flat plate are bent along side peripheries of said opening to form said side peripheries into said movable parts and to form a portion between said side peripheries into said fixing part and said mounting part. 10 15

23. A method of producing a piezoelectric/electrostrictive device comprising a base having a pair of right and left movable parts, a fixing part that connects the two movable parts with each other at one end thereof, a mounting part that is separate from said fixing part and connects the two movable parts with each other at the other end thereof, and a connecting part that is integral with said mounting part and surrounds said mounting part, said movable parts, and said fixing part as well as a piezoelectric/electrostrictive element disposed on at least one side of said two movable parts of the base, wherein said method comprises the steps of preparing a flexible and bendable flat plate as a material for forming said base, stamping said flat plate into a shape that delineates a plane development of said base to form a stamped structure, and bending said stamped structure at a predetermined site to form the base having said movable parts, said fixing part, said mounting part, and said connecting part. 20 25 30 35

24. The method of producing a piezoelectric/electrostrictive device according to claim 23, wherein said stamped structure has a rectangular flat plate part located inside a central opening of a rectangular flat plate and has an H-shaped opening composed of a pair of straight side grooves located at right and left sides of said flat plate part and extending along side peripheries and a straight central groove that connects the two side grooves with each other at a middle part, and the side peripheries of said flat plate part are bent along said side grooves to form said side peripheries into said movable parts, to form a portion between said side grooves into said fixing part and said mounting part, and to form a portion around said central opening into said connecting part. 40 45 50

25. The method of producing a piezoelectric/electrostrictive device according to claim 18, 19, 20, 21, 22, 23, or 24, wherein an opening of said stamped structure is formed by stamping simultaneously with 55 stamping said flat plate or formed by a hole-forming process after stamping said flat plate.

Fig. 1A

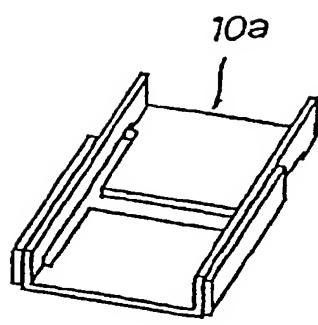


Fig. 1B

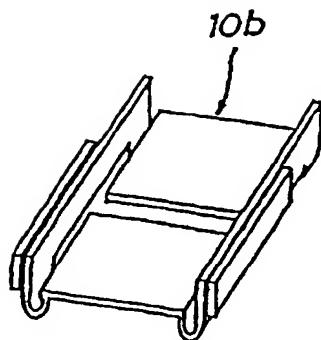


Fig. 1C

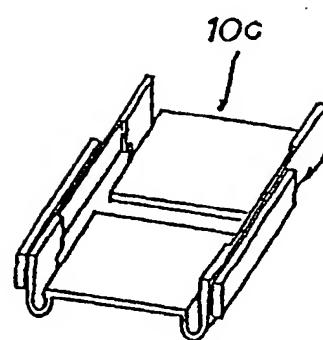


Fig. 1D

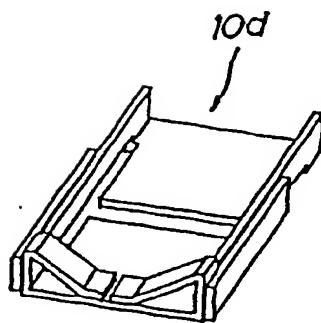


Fig. 1E

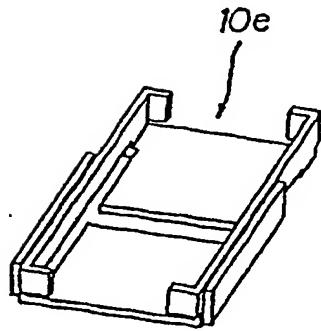


Fig. 1F

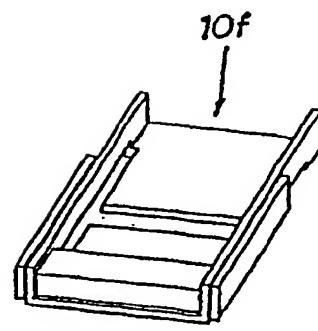


Fig. 1G

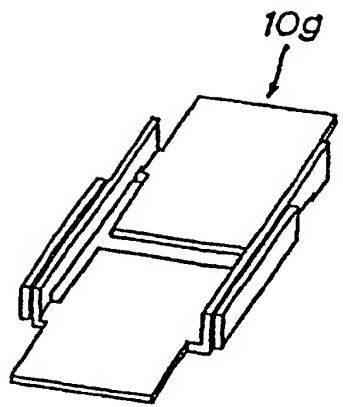


Fig. 1H

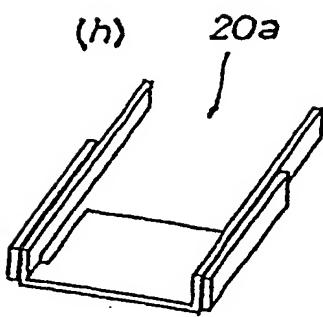


Fig. 1I

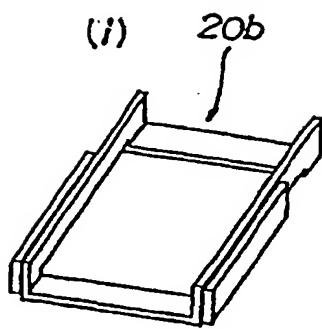


Fig. 1J

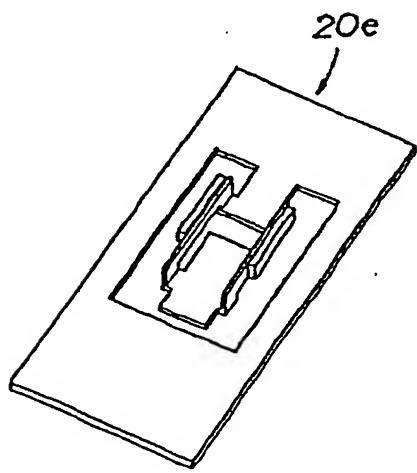


Fig. 1K

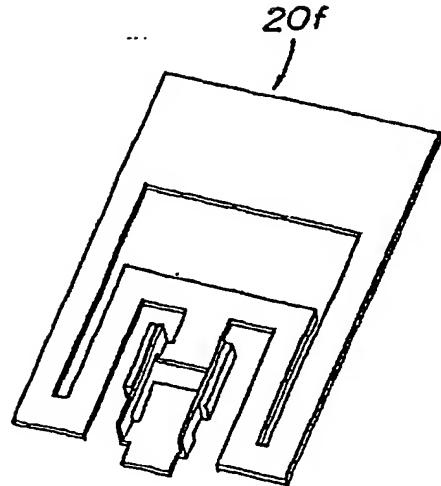


Fig. 2

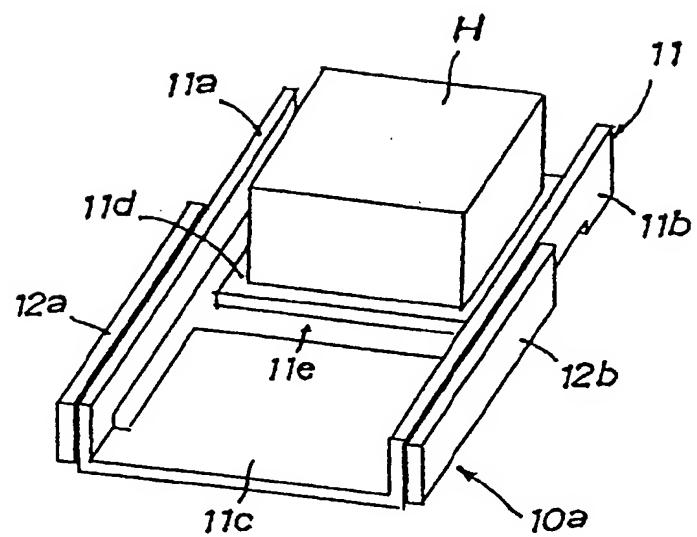


Fig. 3A

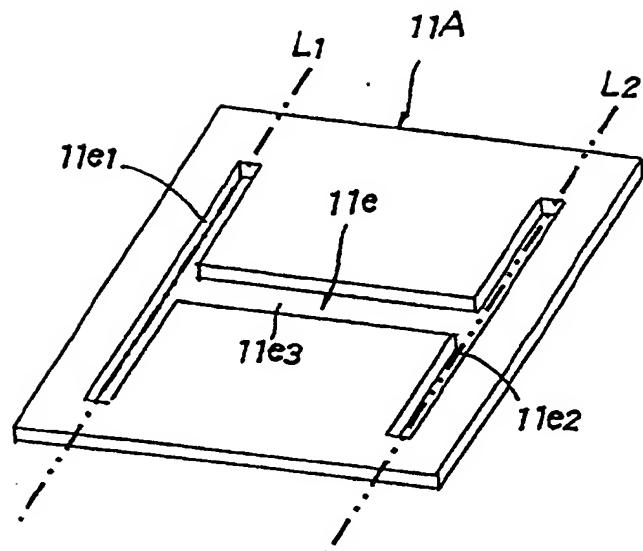


Fig. 3B

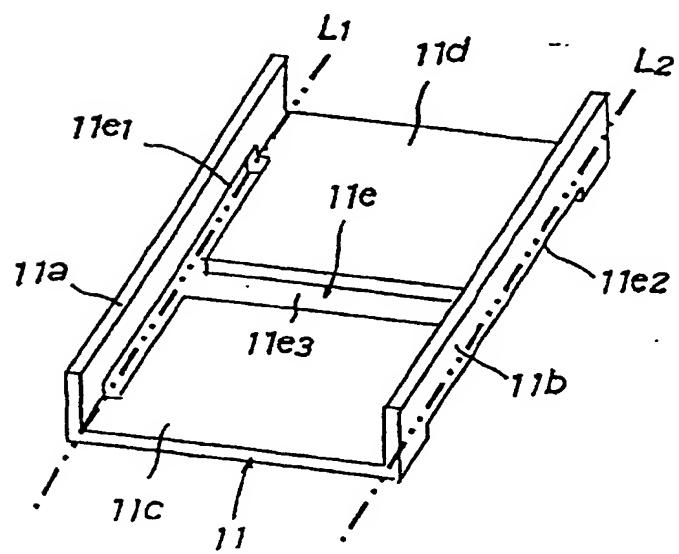


Fig. 4A

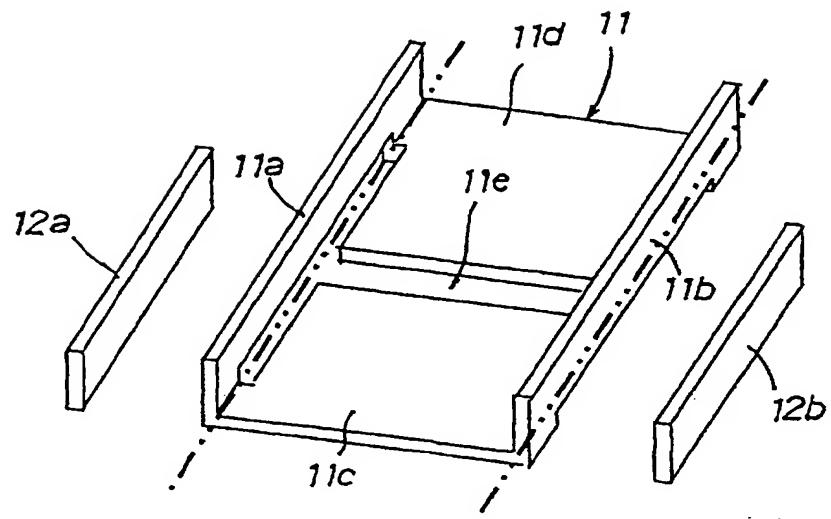


Fig. 4B

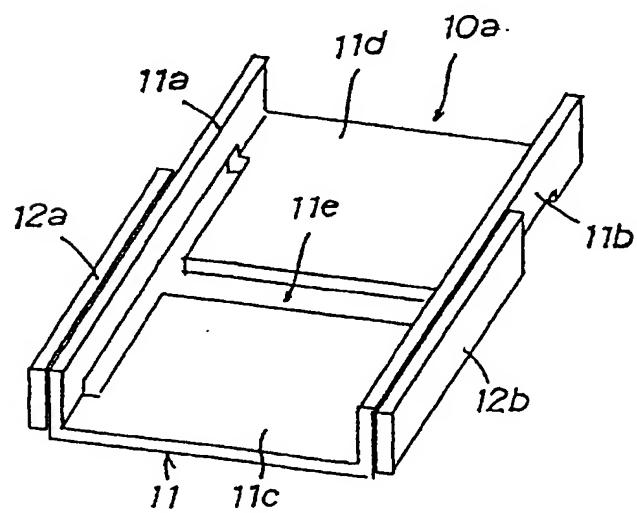


Fig. 5A

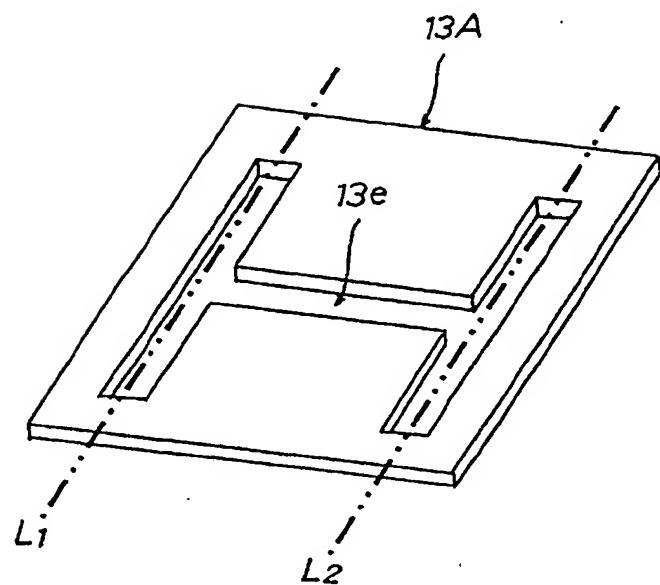


Fig. 5B

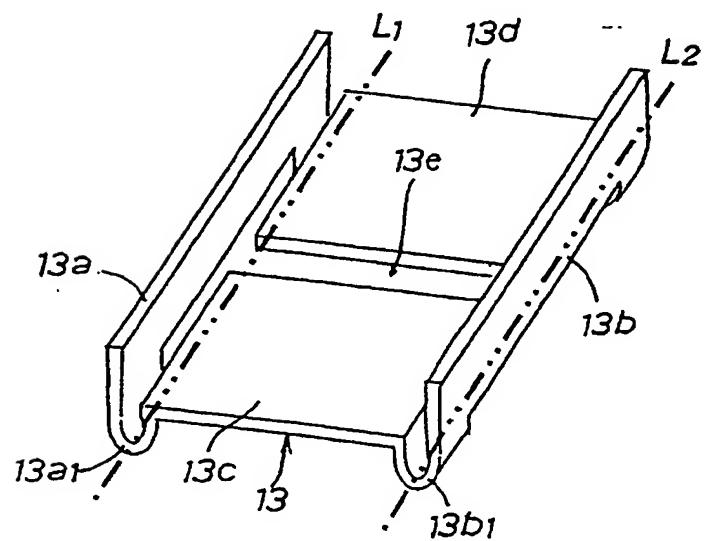


Fig. 6A

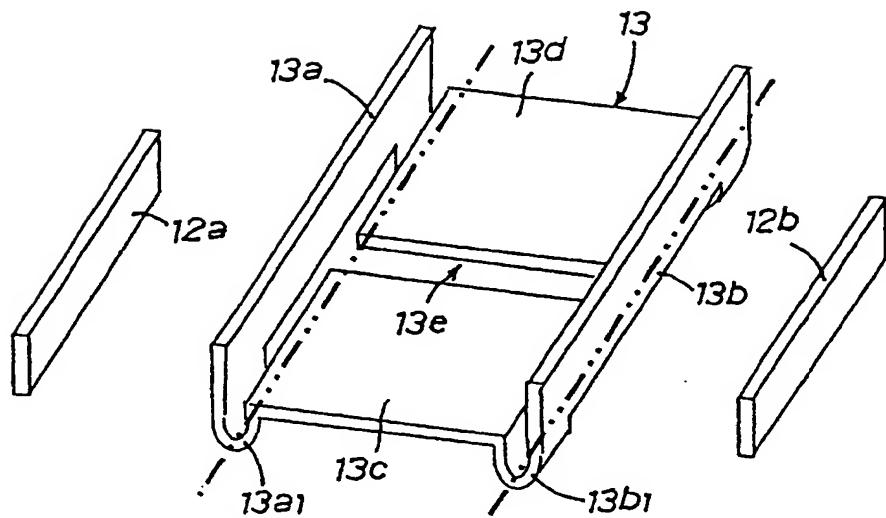


Fig. 6B

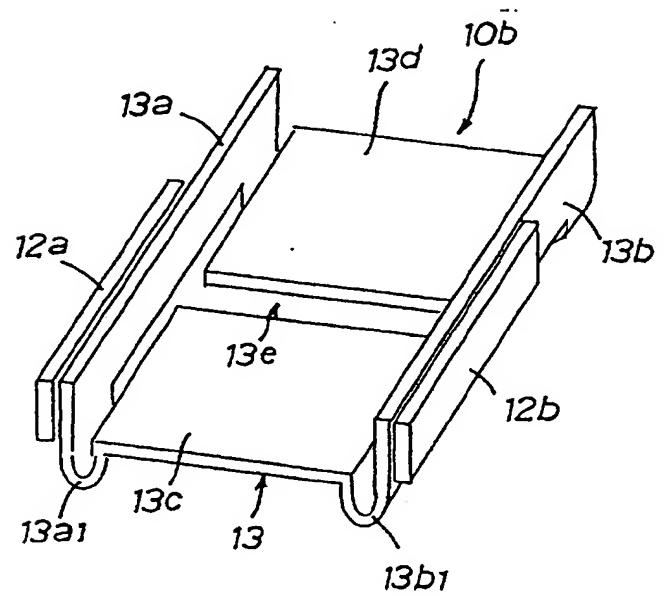


Fig. 7A

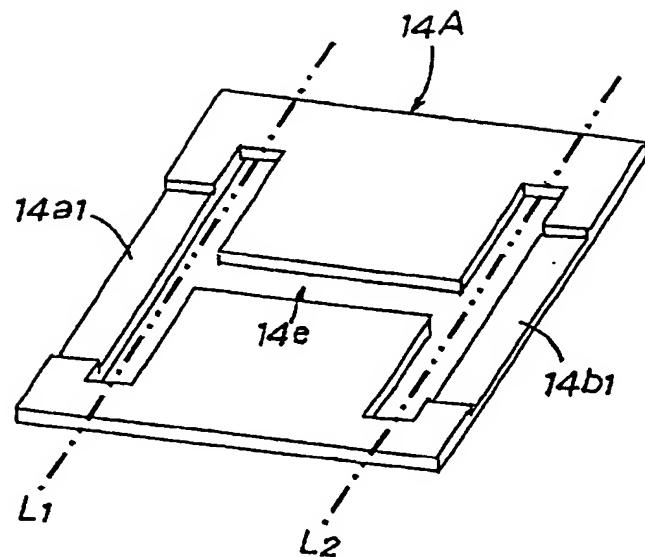


Fig. 7B

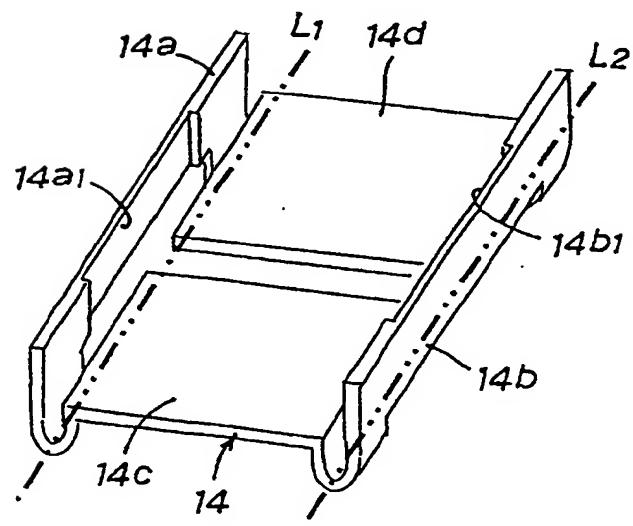


Fig. 8A

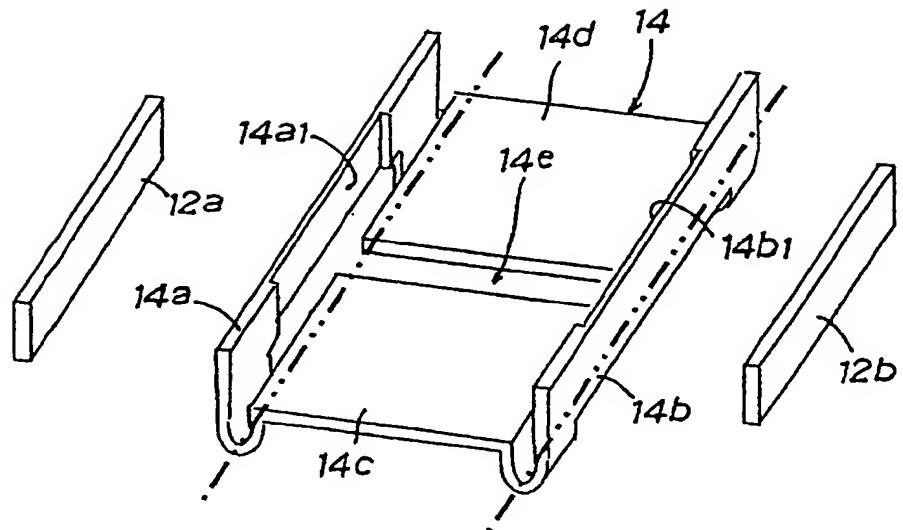


Fig. 8B

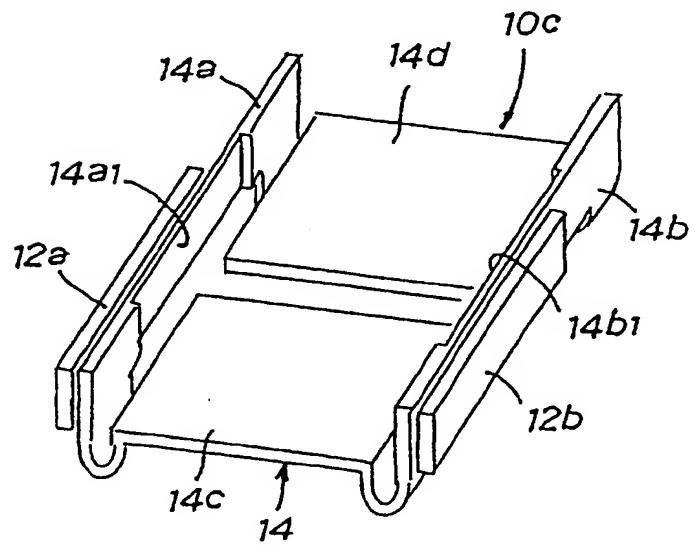


Fig. 9A

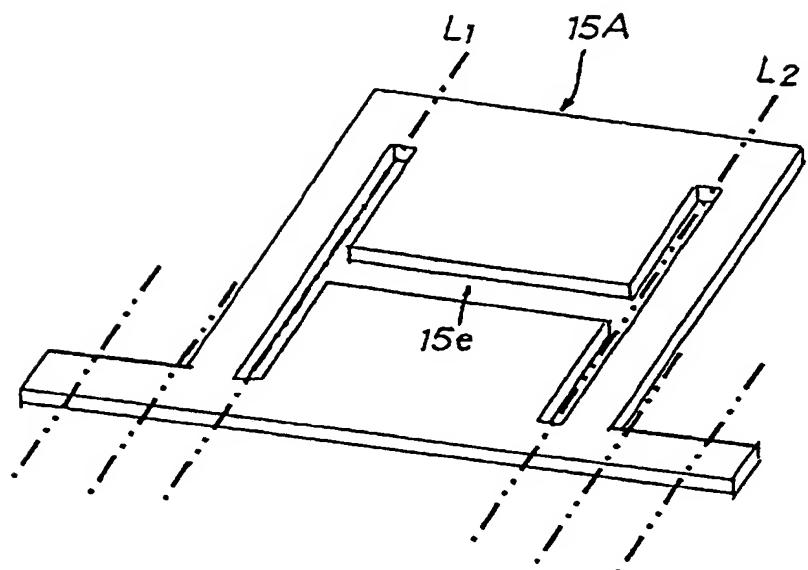


Fig. 9B

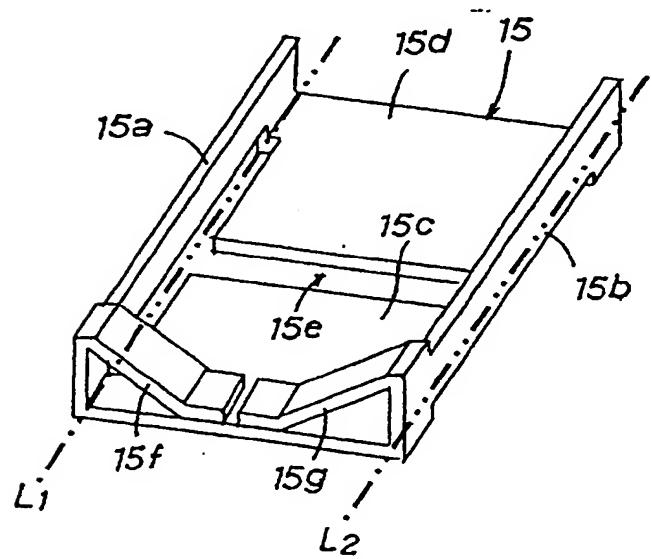


Fig. 10A

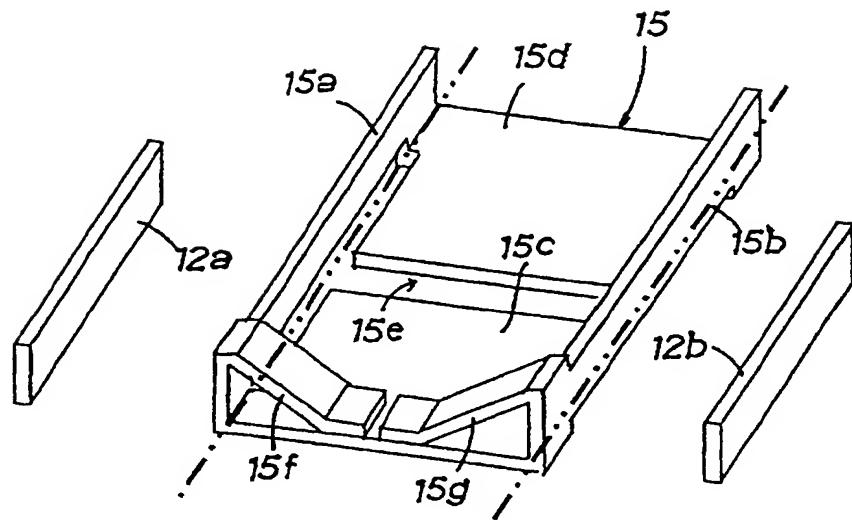


Fig. 10B

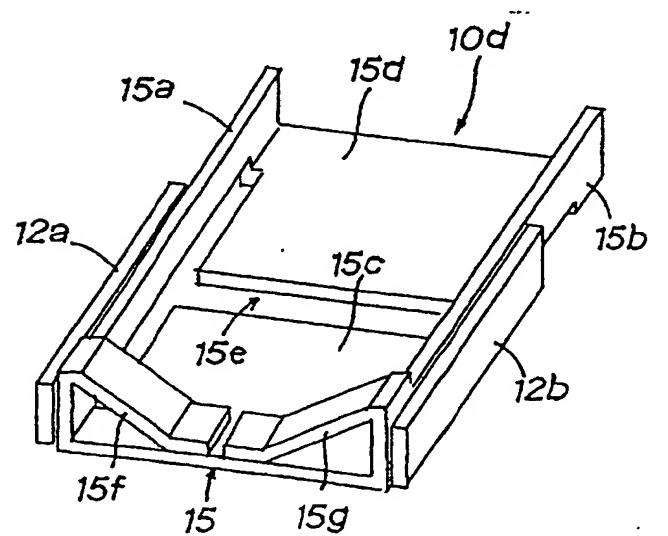


Fig. 11A

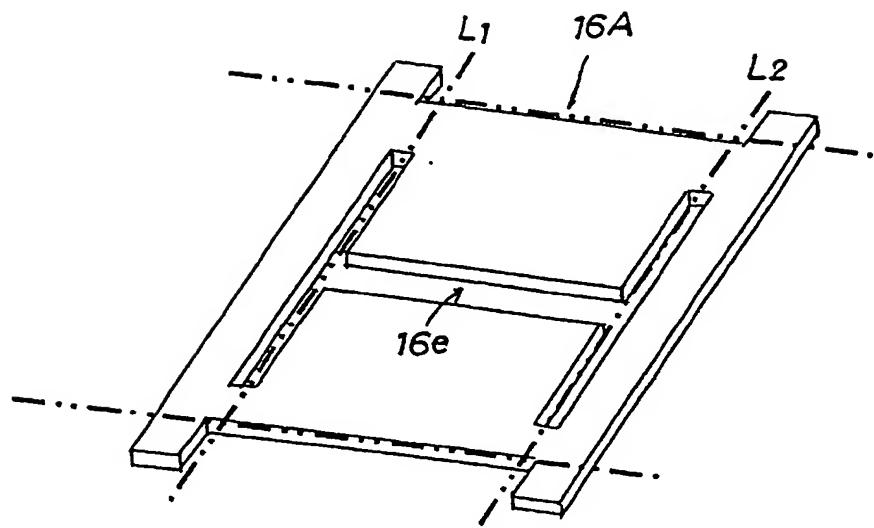


Fig. 11B

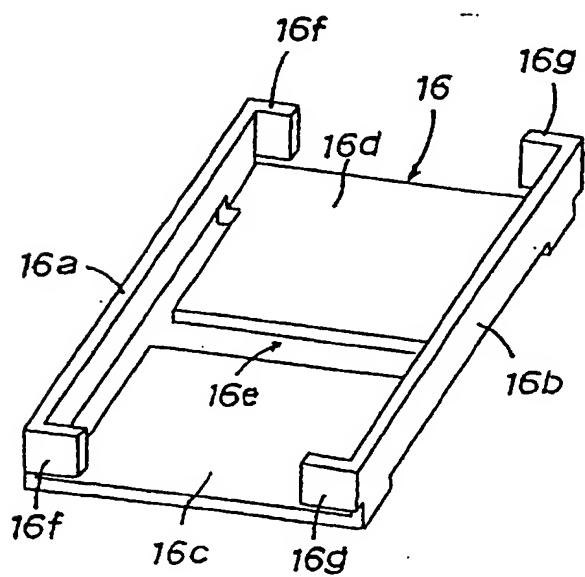


Fig. 12A

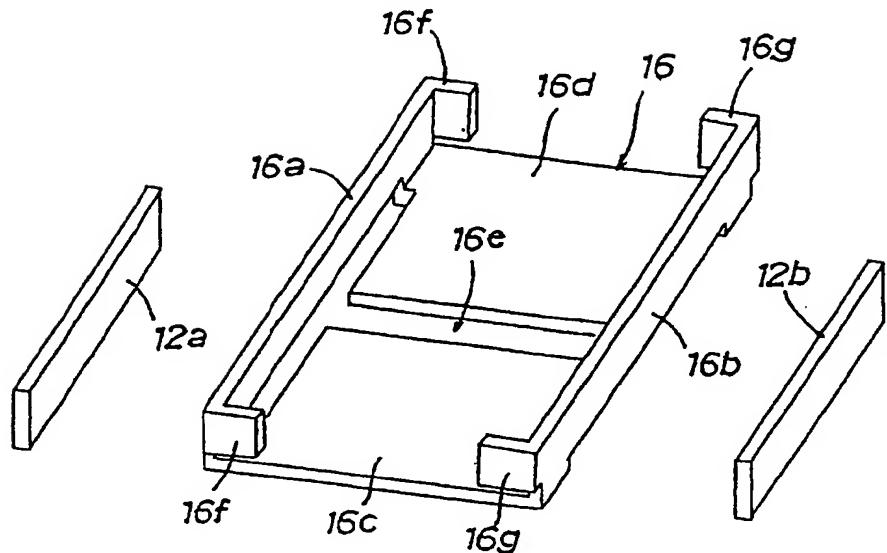


Fig. 12B

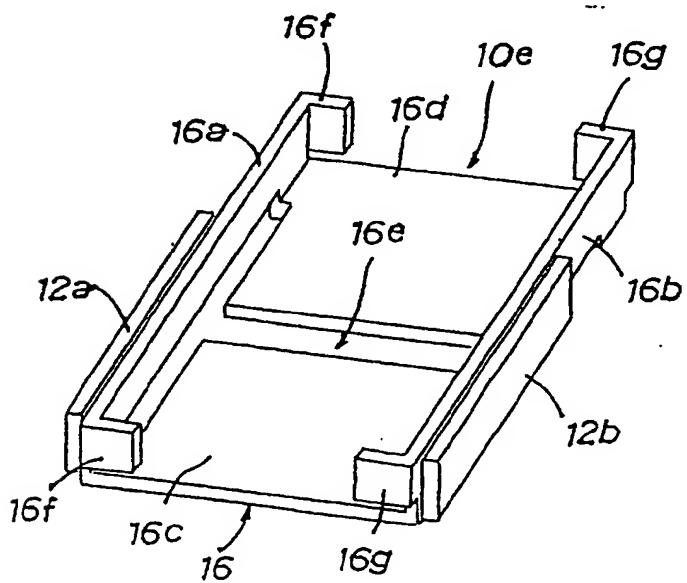


Fig. 13A

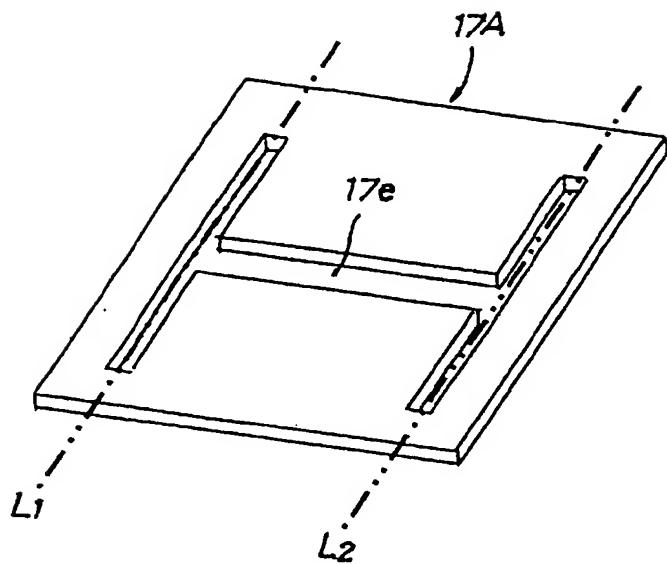


Fig. 13B

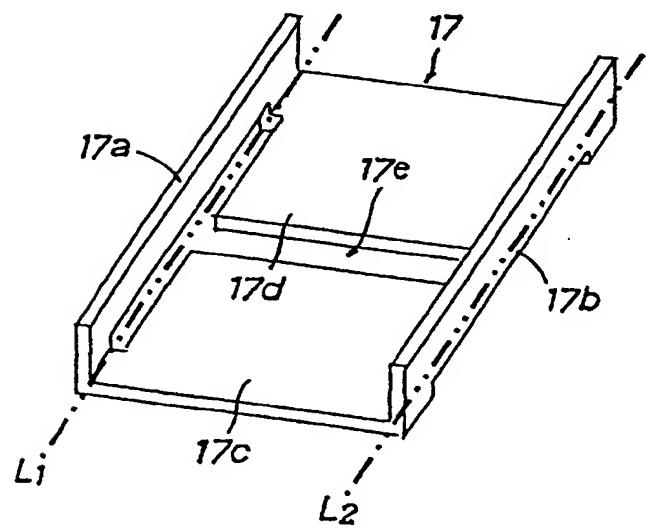


Fig. 14A

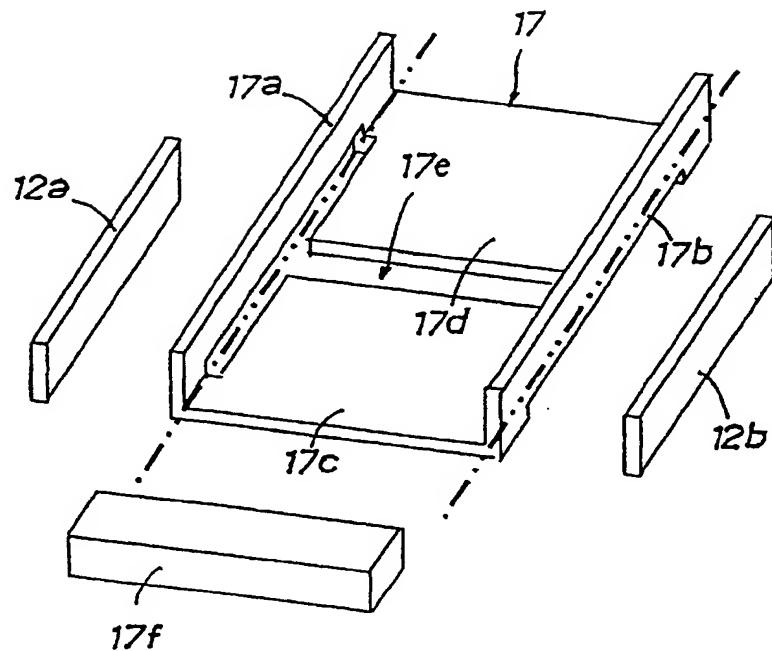


Fig. 14B

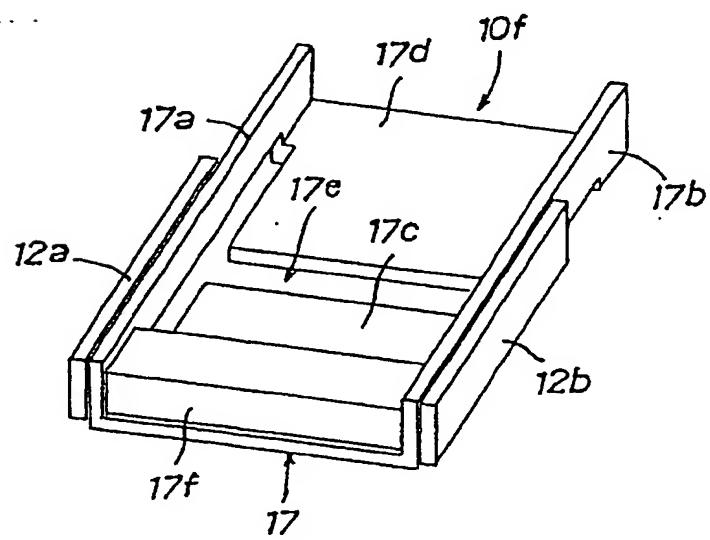


Fig. 15A

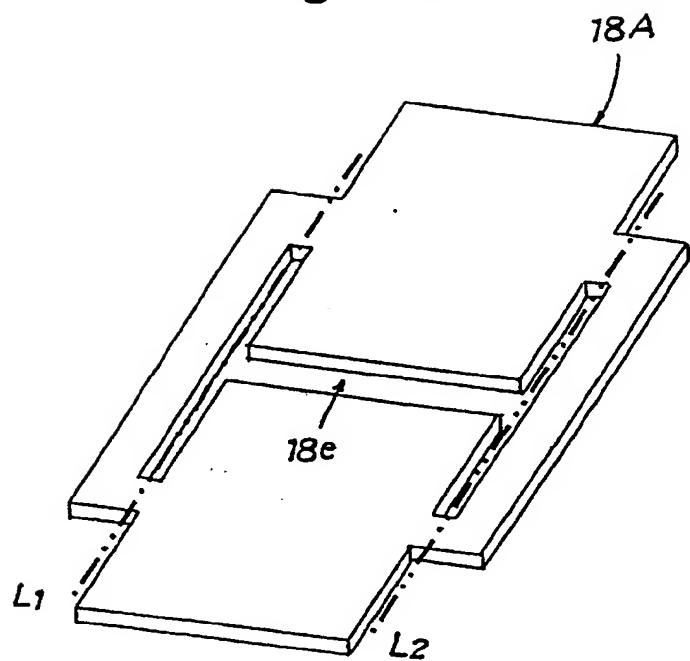


Fig. 15B

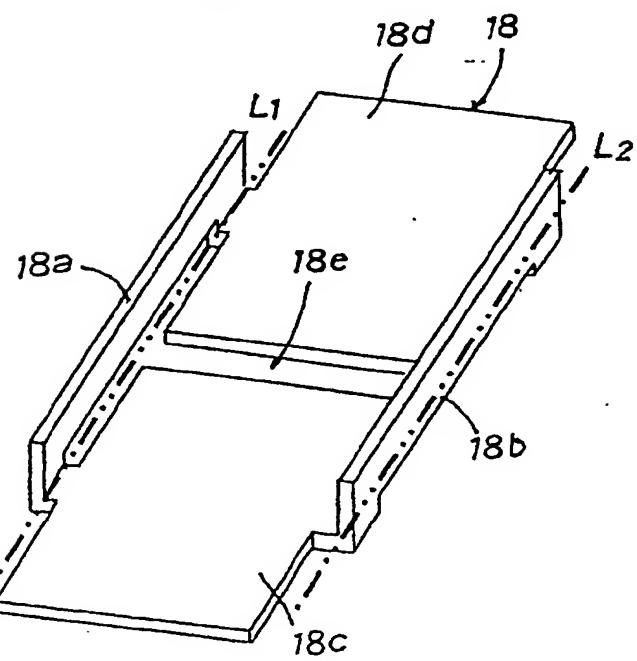


Fig. 16A

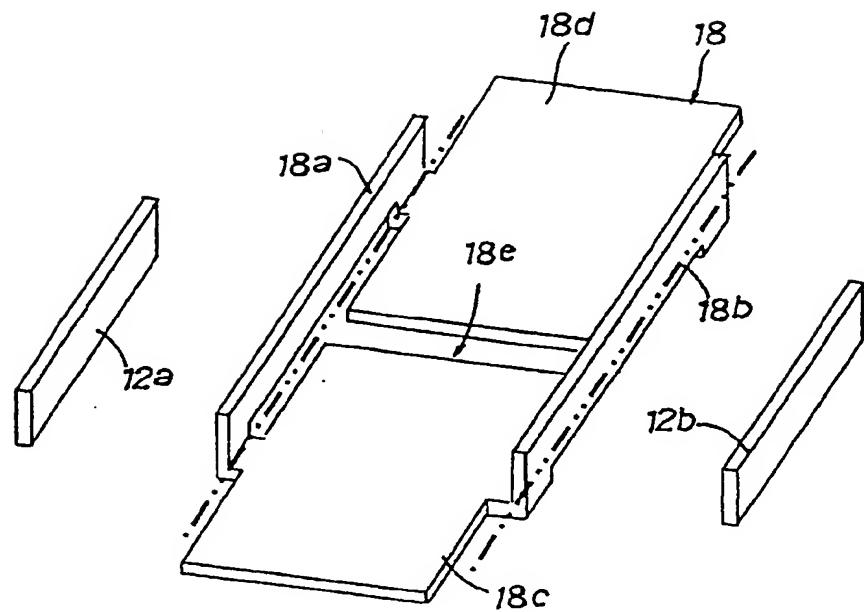


Fig. 16B

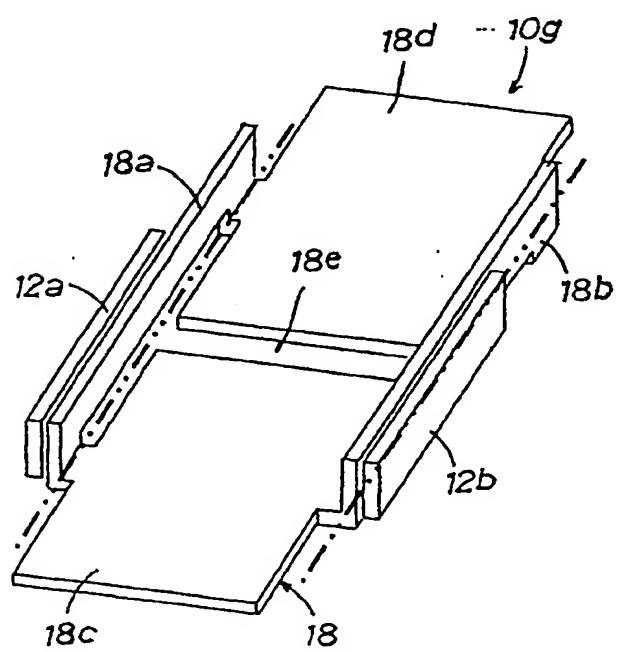


Fig. 17A

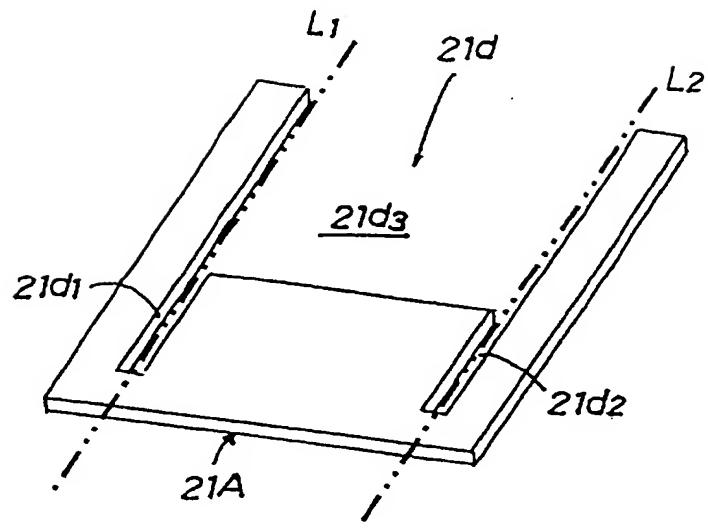


Fig. 17B

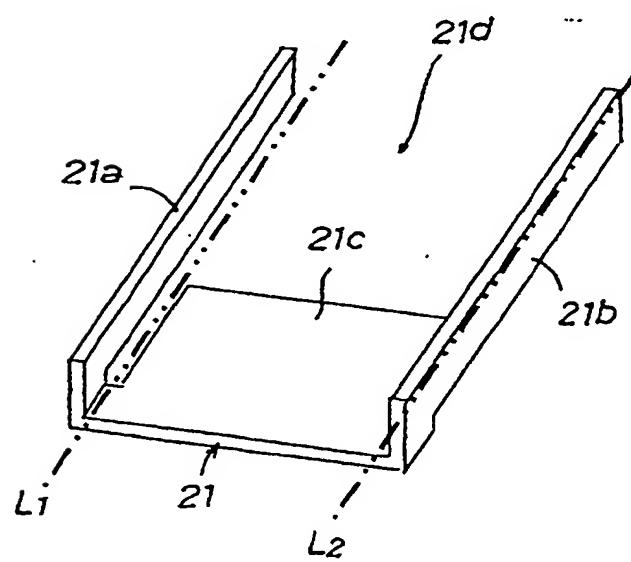


Fig. 18A

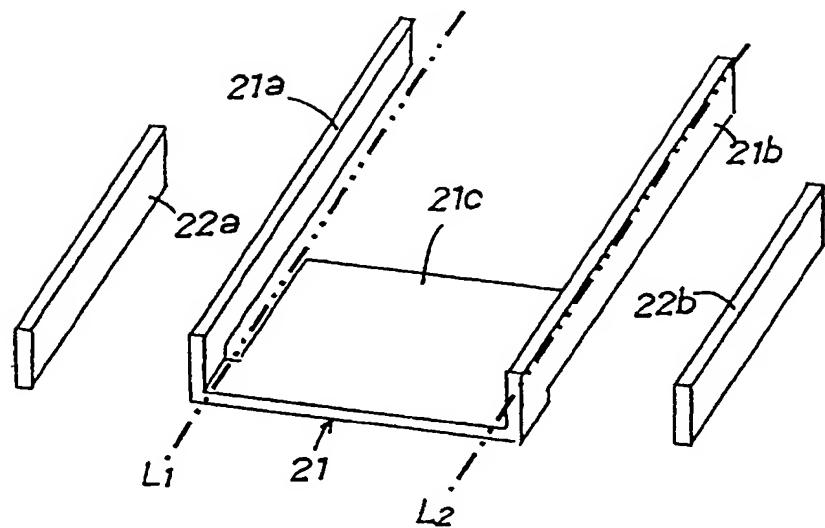


Fig. 18B

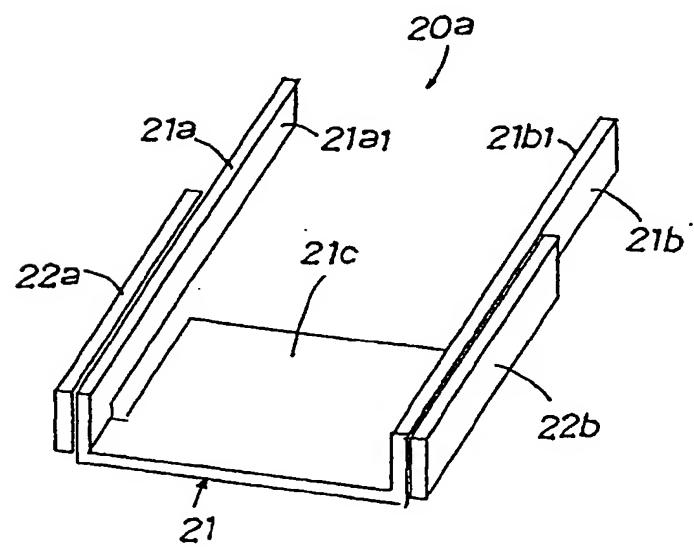


Fig. 19

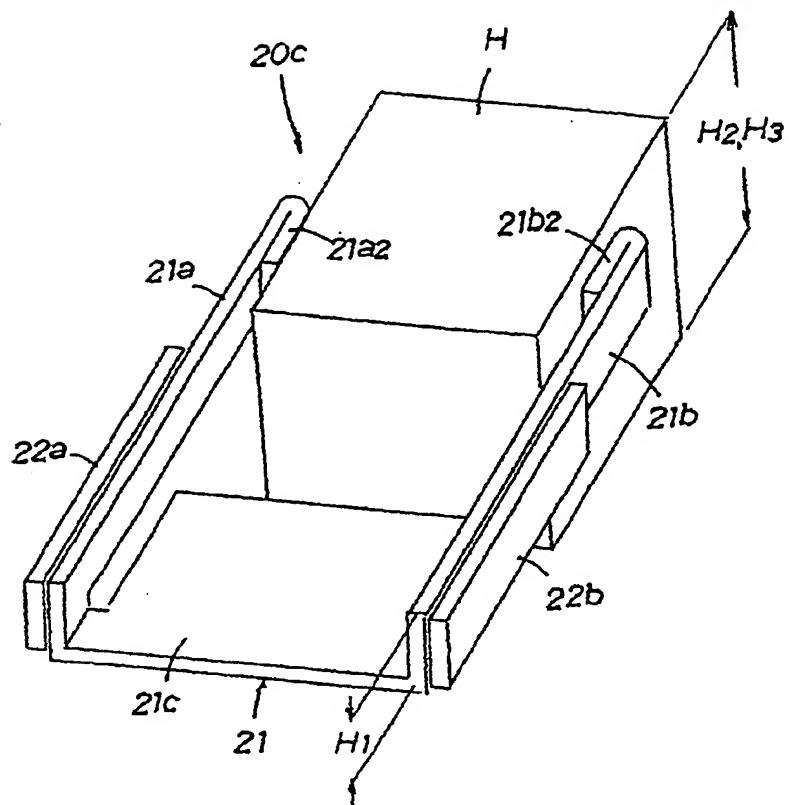


Fig. 20

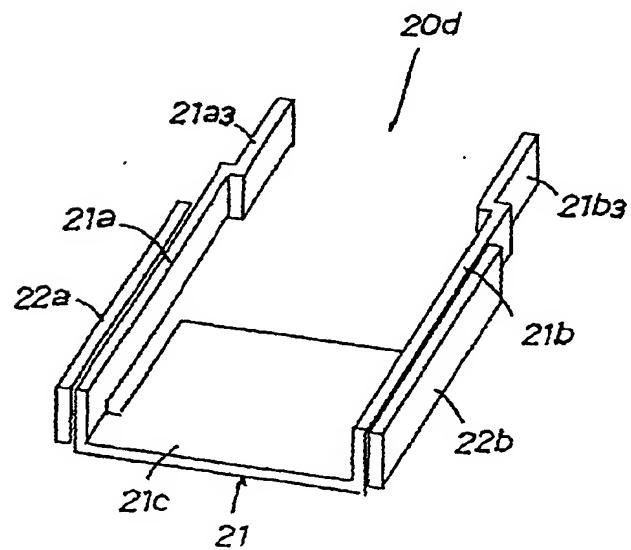


Fig. 21A

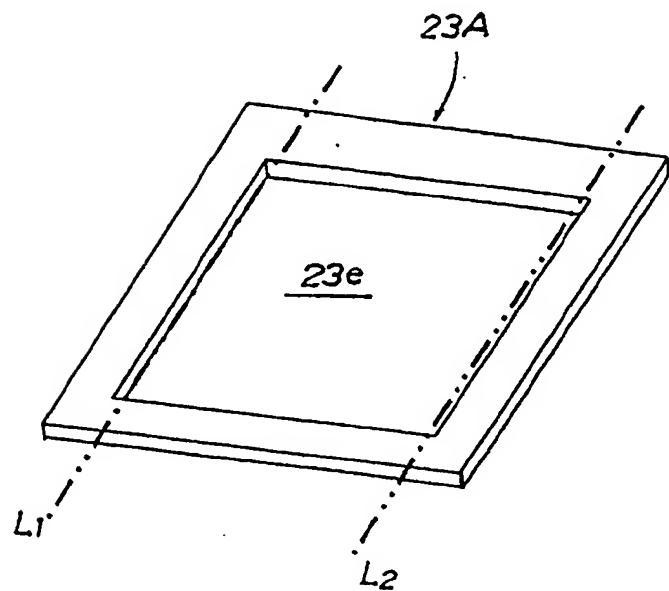


Fig. 21B

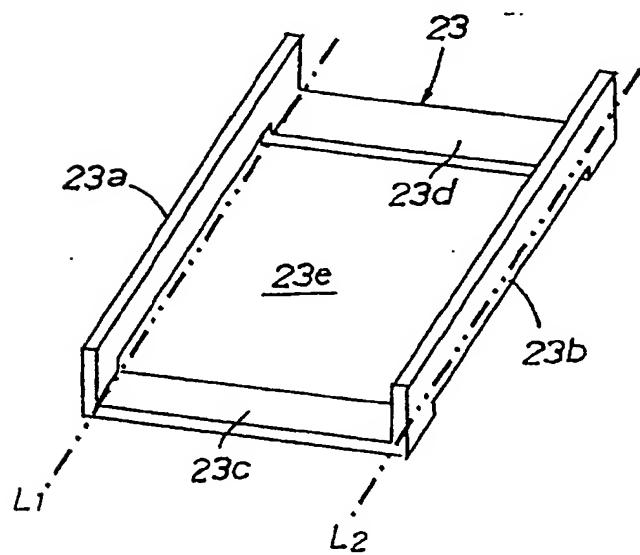


Fig. 22A

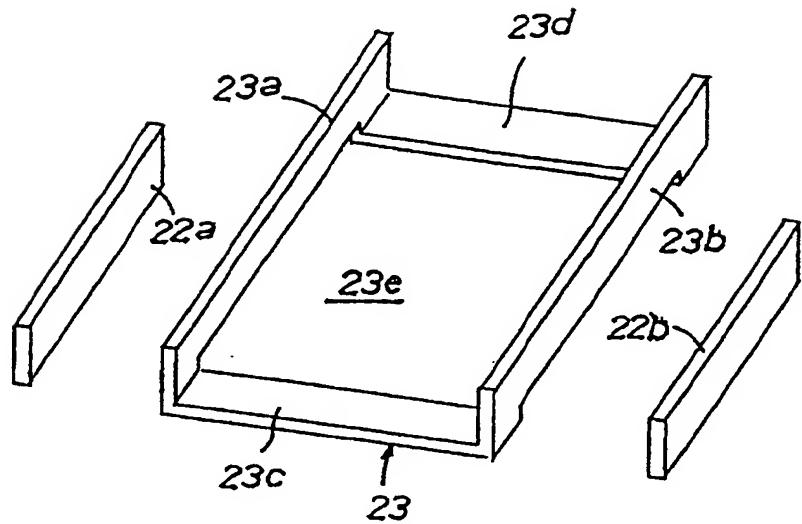


Fig. 22B

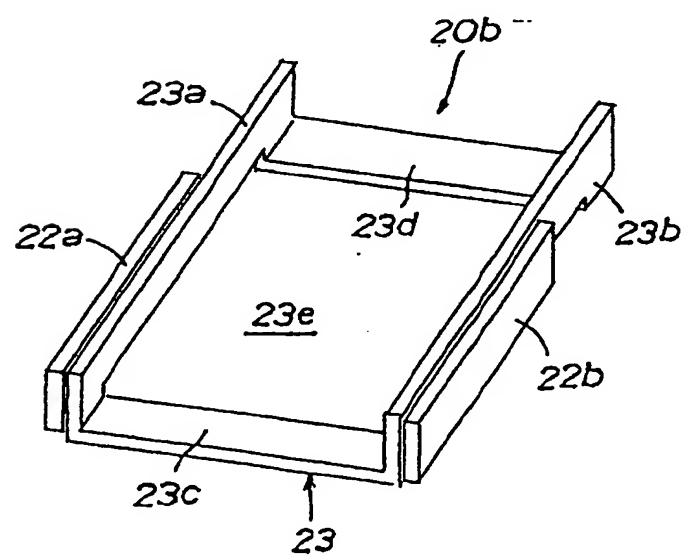


Fig. 23A

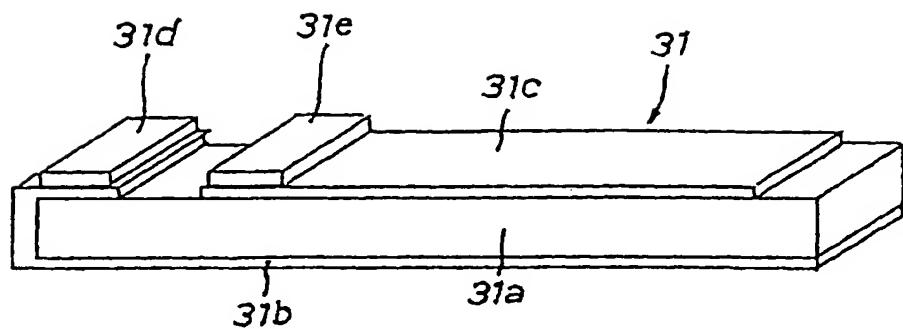


Fig. 23B

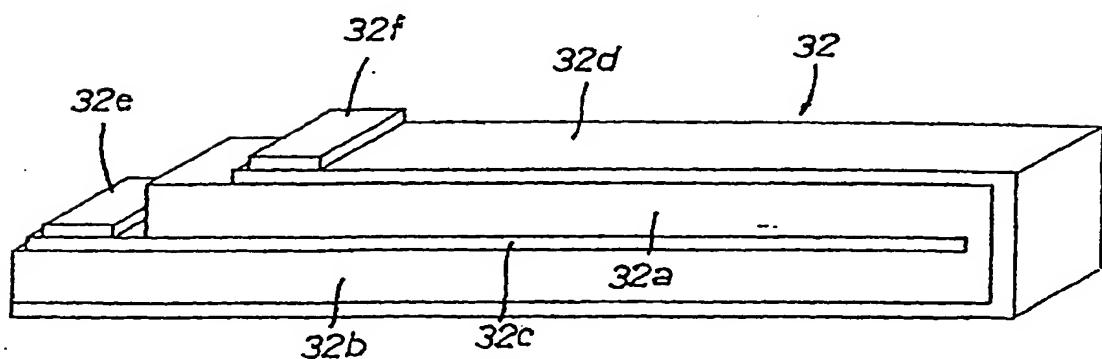


Fig. 24A

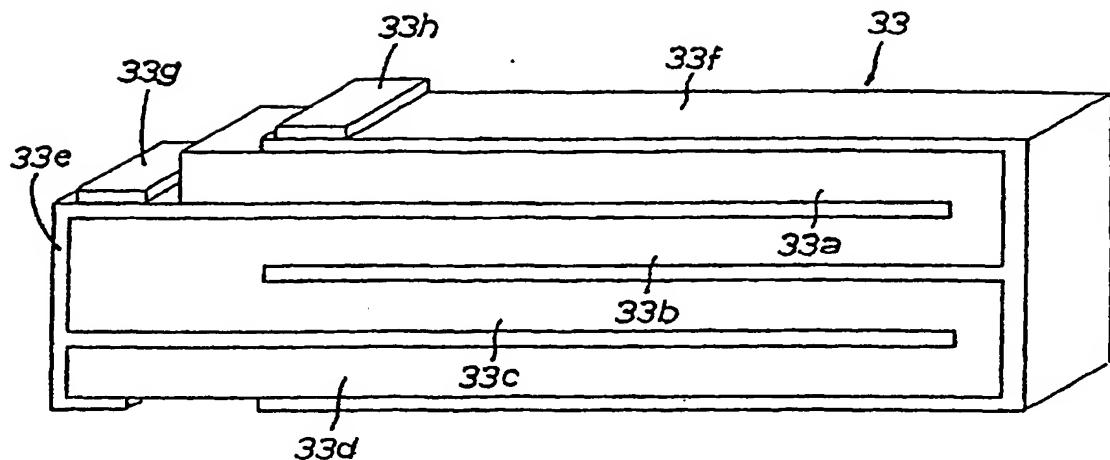


Fig. 24B

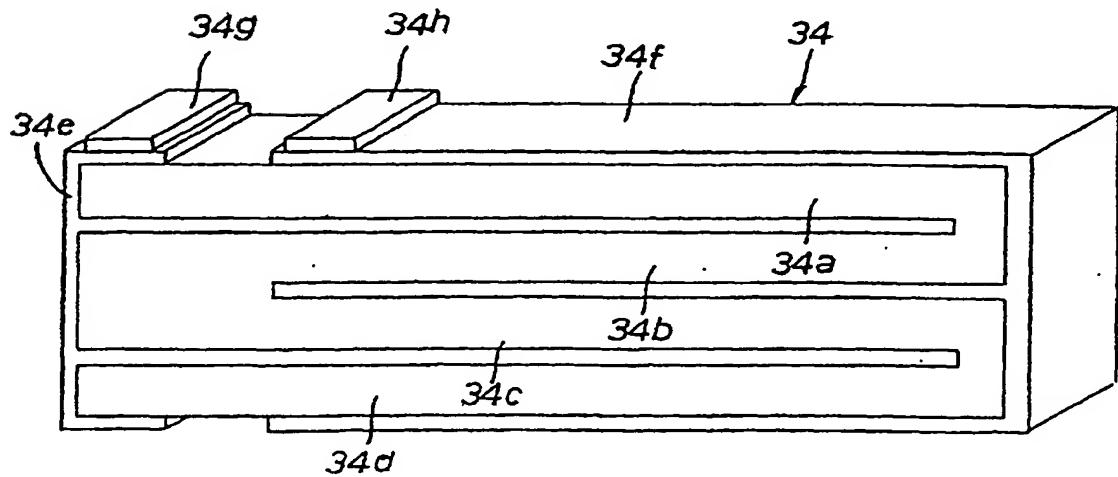


Fig. 25

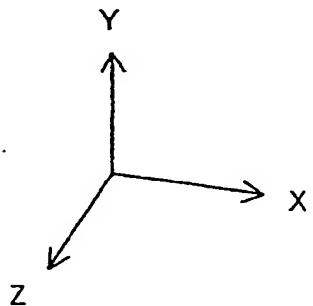
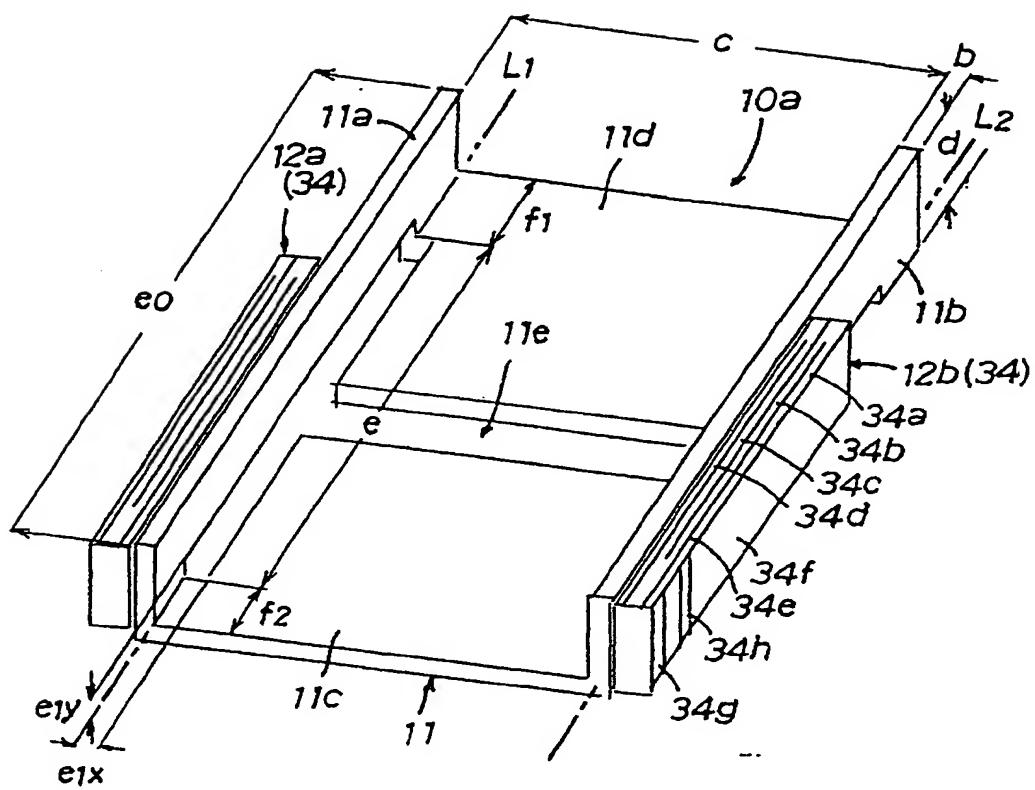


Fig. 26

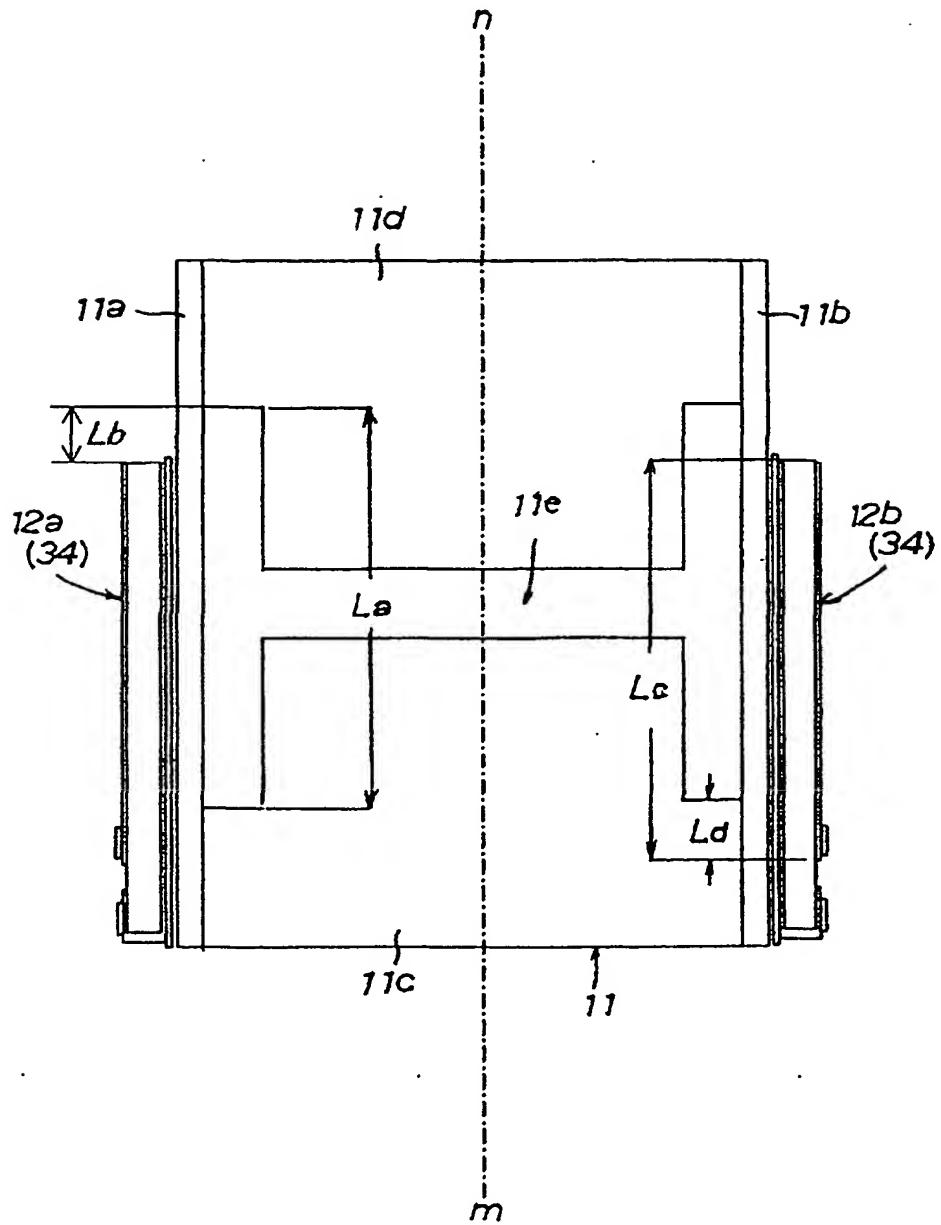


Fig. 27A

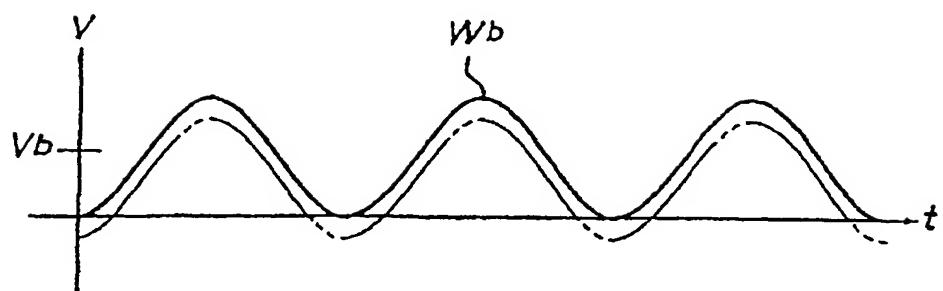


Fig. 27B

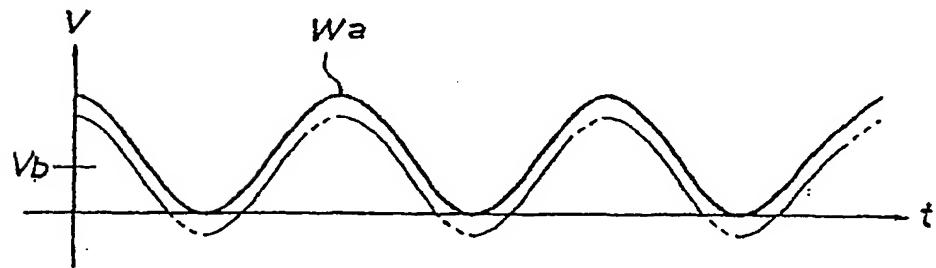


Fig. 28

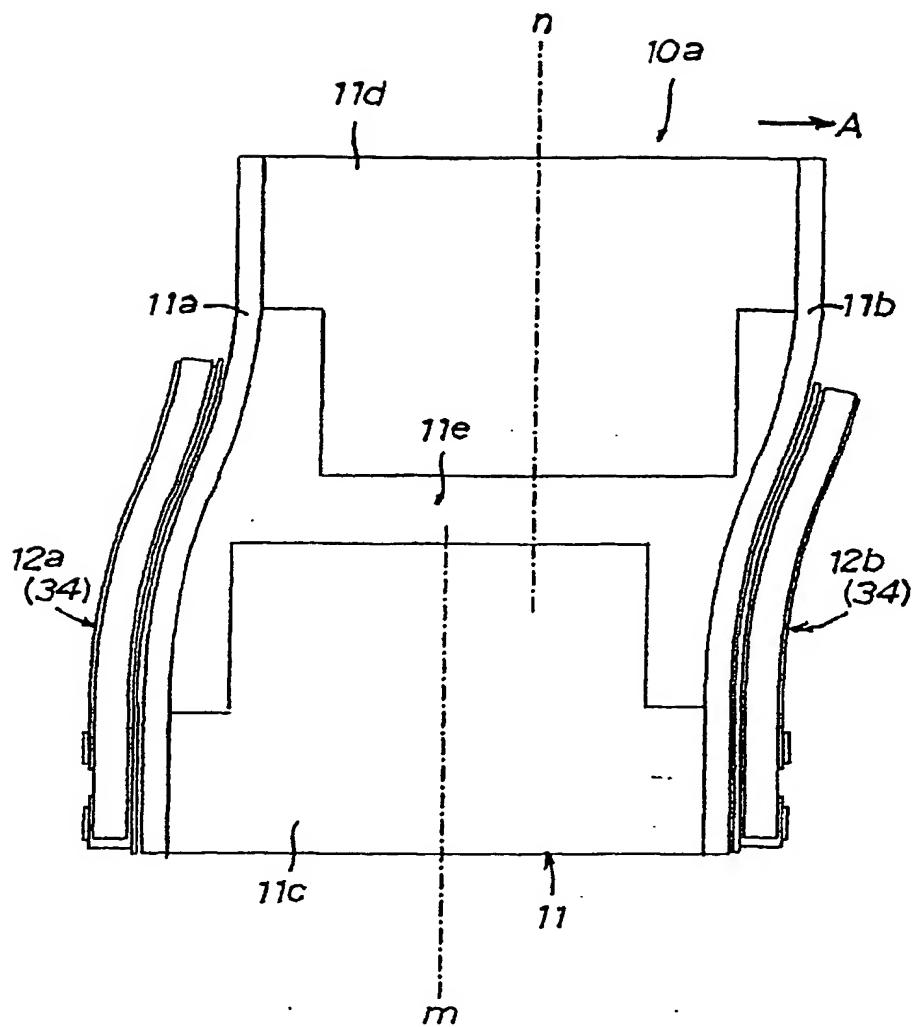


Fig. 29

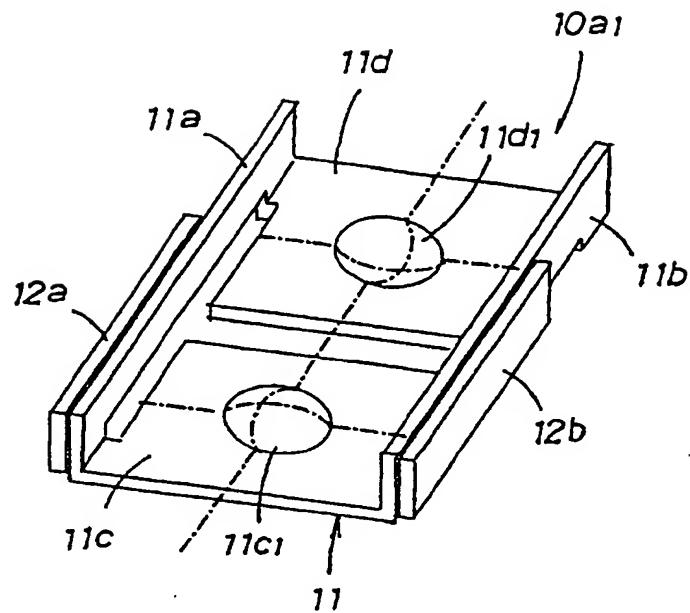


Fig. 30

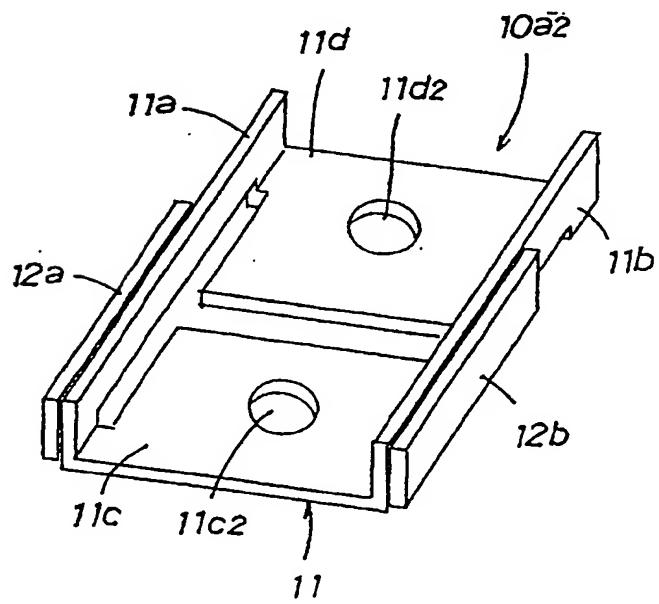


Fig. 31

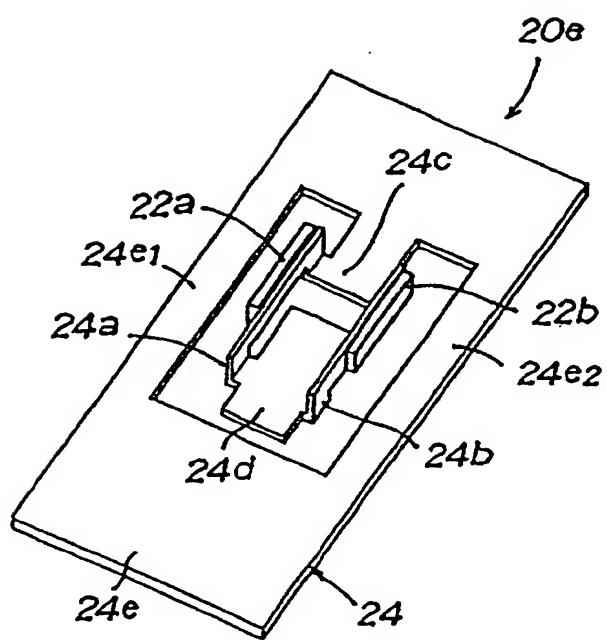


Fig. 32A

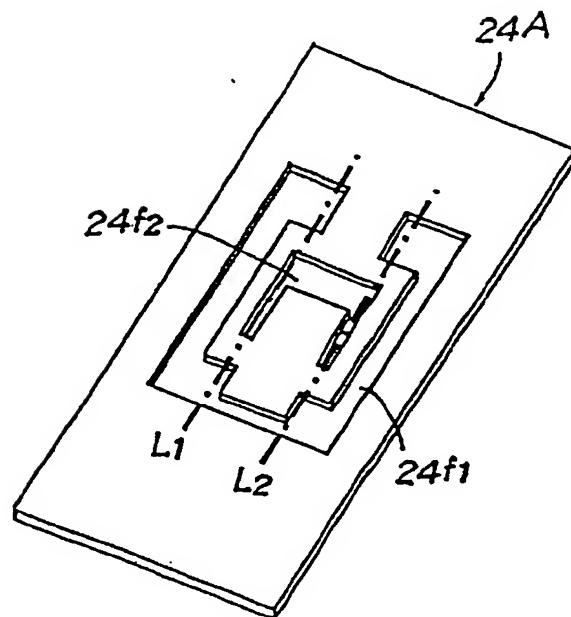


Fig. 32B

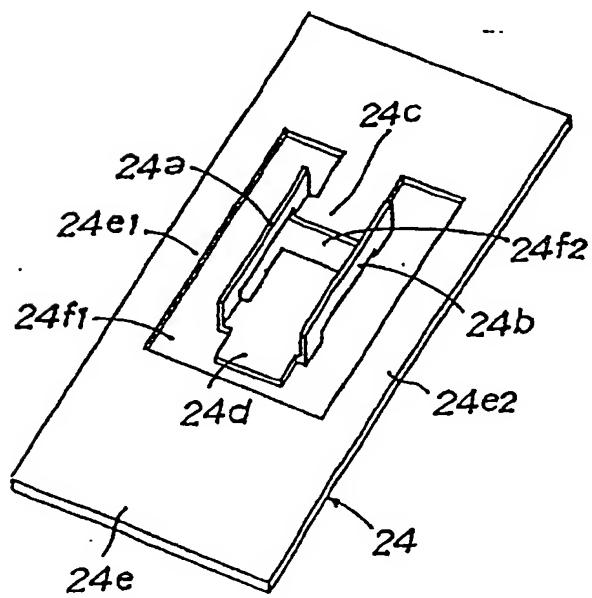


Fig. 33

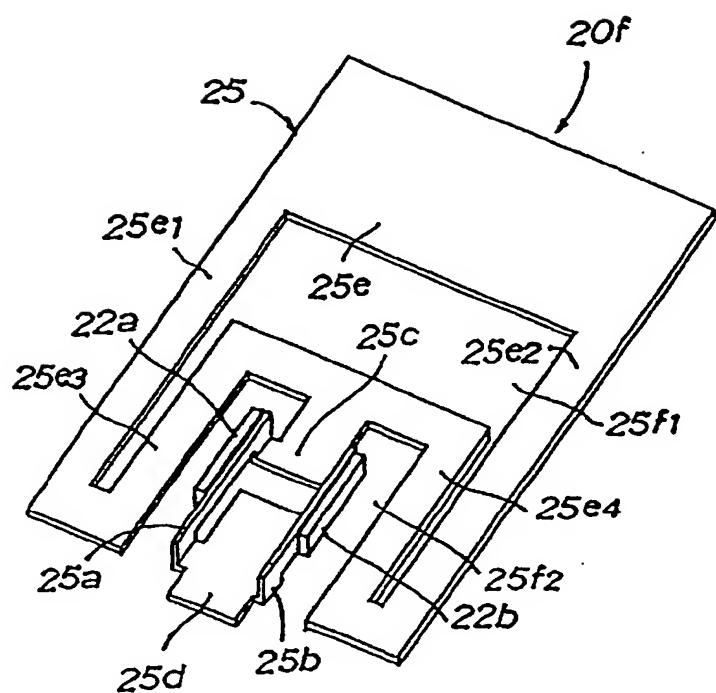


Fig. 34A

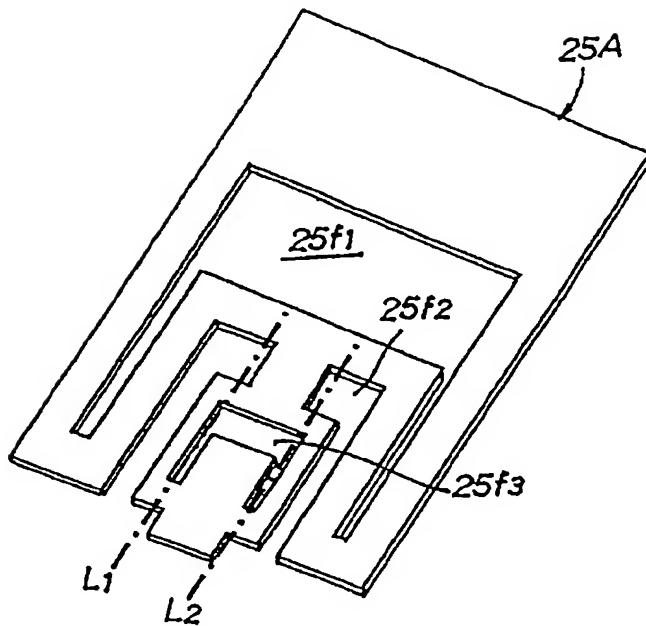


Fig. 34B

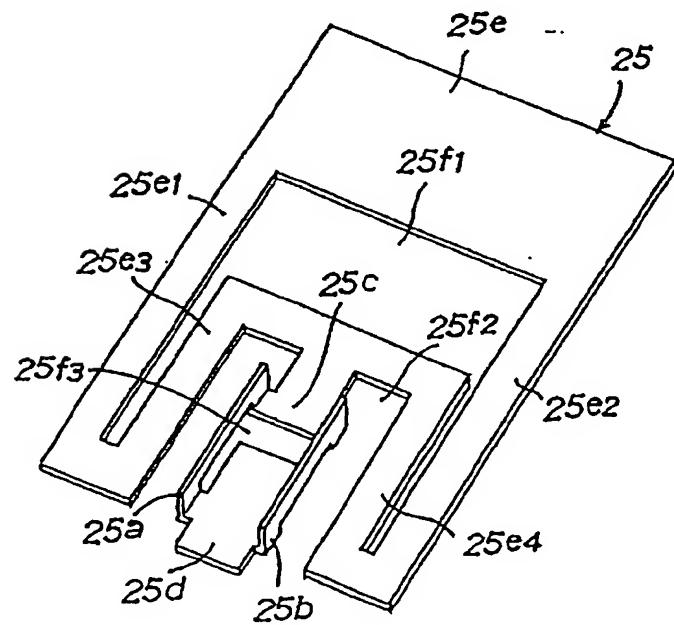


Fig. 35

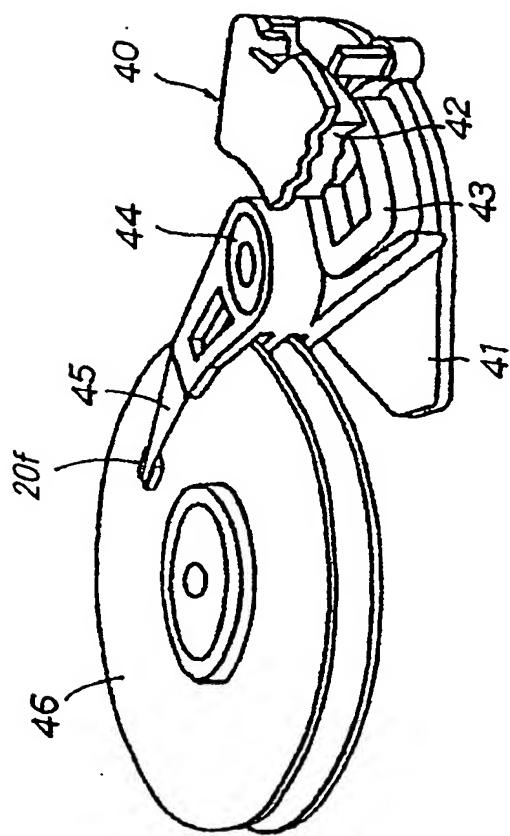


Fig. 36A

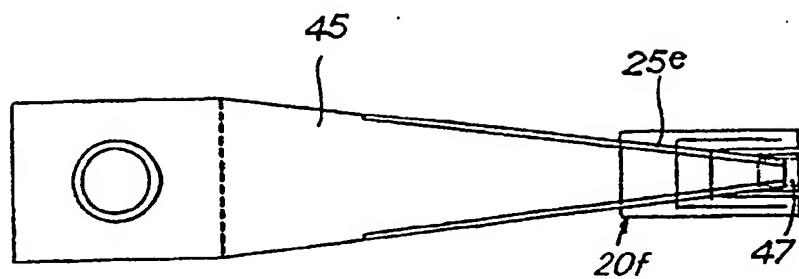
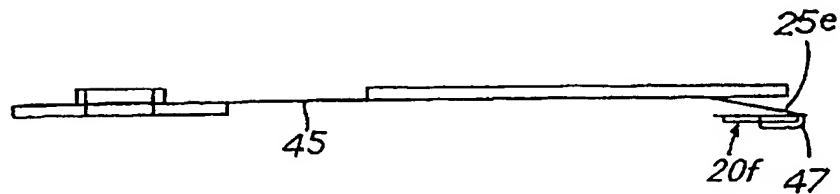


Fig. 36B



(19)



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(11)

EP 1 225 644 A3



(12)

## EUROPEAN PATENT APPLICATION

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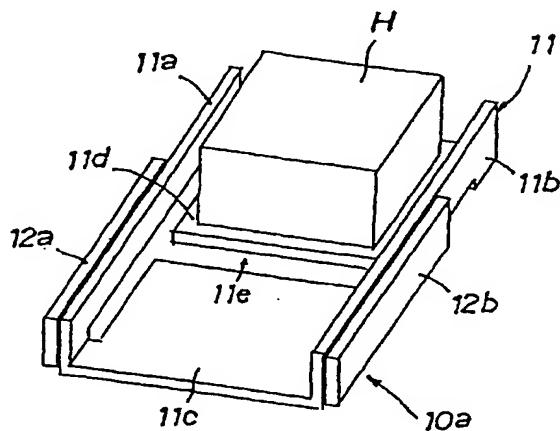
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### (54) Piezoelectric/electrostrictive device and method of producing the same

(57) A piezoelectric/electrostrictive device that includes a base 11 having a pair of right and left movable parts 11a, 11b and a fixing part 11c disposed at one end thereof as well as piezoelectric/electrostrictive elements 12a, 12b disposed on the sides of the movable parts 11a, 11b of the base 11 is fabricated to have a construction with fewer components. The piezoelectric/electrostrictive device having a construction with fewer components is provided by adopting a base 11 having an integral structure formed by bending an original plate stamped into a shape that delineates a plane development of the base, as the base of the piezoelectric/electrostrictive device.

Fig. 2



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DOCUMENTS CONSIDERED TO BE RELEVANT			CLASSIFICATION OF THE APPLICATION (Int.Cl.)
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.)
X	EP 0 503 762 A (AMPEX) 16 September 1992 (1992-09-16)  * column 16, line 11 - line 38; figures 4-10, 12 * -----	1,2,9, 11-15, 17-19,25	H01L41/08 H01L41/22 G11B5/48
A	EP 1 020 937 A (TOKAI RIKA CO LTD ; ARAI FUMIHIKO (JP); FUKUDA TOSHIO (JP)) 19 July 2000 (2000-07-19) * figure 1 * -----	1,2,9, 11-15, 17-19,25	
A	US 4 612 440 A (DOBBERSTEIN PETER ET AL) 16 September 1986 (1986-09-16)  * figures 3,5,7 * -----	1,2,9, 11-15, 17-19,25	
A	US 5 500 777 A (HASEGAWA KENJI ET AL) 19 March 1996 (1996-03-19)  * figures 1,2 * -----	1,2,9, 11-15, 17-19,25	
A	DE 30 21 430 A (SONY CORP) 18 December 1980 (1980-12-18)  * figures 5,6,8,9 * -----	1,2,9, 11-15, 17-19,25	H01L G11B
A	US 5 892 640 A (GOTO SHIGENOBU) 6 April 1999 (1999-04-06)  * figures 1,4,5 * -----	1,2,9, 11-15, 17-19,25	
A	EP 0 742 597 A (FRANCE ETAT) 13 November 1996 (1996-11-13)  * pages 1,2,4 * -----	1,2,9, 11-15, 17-19,25	
			-/--
The present search report has been drawn up for all claims			
2	Place of search Munich	Date of completion of the search 11 July 2005	Examiner Gröger, A
CATEGORY OF CITED DOCUMENTS		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	
EPO FORM 1502.02aZ (PdC01)			
X : particularly relevant ; taken alone Y : particularly relevant ; combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document			



DOCUMENTS CONSIDERED TO BE RELEVANT			CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
A	GB 1 328 931 A (CREED CO LTD) 5 September 1973 (1973-09-05)  * figure 2 * -----	1,2,9, 11-15, 17-19,25	
A	US 4 438 469 A (KOGA HIROHISA ET AL) 20 March 1984 (1984-03-20)  * figure 6 * -----	1,2,9, 11-15, 17-19,25	
X	WO 00/16318 A (MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD; YOKOYAMA, KAZUO; YAMAMOTO, SH) 23 March 2000 (2000-03-23)	1-3,5, 10-17, 20,22,23	
Y	* paragraph '0066! - paragraph '0069! *  * paragraph '0106! - paragraph '0122! * -& EP 1 152 401 A (MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD) 7 November 2001 (2001-11-07) * paragraph '0106! - paragraph '0122!; figures 1,2,6-11,13-16 * * paragraph '0066! - paragraph '0069! * -----	3,4,6-8, 20,21, 23,24	TECHNICAL FIELDS SEARCHED (Int.Cl.7)
X,P	-----	1-3,5,8, 10-17, 20,22,23	
Y,P	-----	6,7,20, 21,23,24	
X	WO 98/44488 A (SEAGATE TECHNOLOGY, INC; STEFANSKY, FREDERICK, M; ALTSCHULER, KENNETH,) 8 October 1998 (1998-10-08) * page 5, line 28 - page 7, line 14; figures 6,7 *	1-3,5,8, 10-16, 20,22,23	
Y	US 5 923 500 A (HAGEN ET AL) 13 July 1999 (1999-07-13) * figures 2,3 *	3,4,20, 21,23,24	
Y	US 5 901 014 A (HIRAOKA ET AL) 4 May 1999 (1999-05-04) * column 13, line 33 - column 15, line 39; figures 23,25,26 *	6-8	
The present search report has been drawn up for all claims			
2	Place of search Munich	Date of completion of the search 11 July 2005	Examiner Gröger, A
CATEGORY OF CITED DOCUMENTS			
X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document			
T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

**CLAIMS INCURRING FEES**

The present European patent application comprised at the time of filing more than ten claims.

- Only part of the claims have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims and for those claims for which claims fees have been paid, namely claim(s):
  
- No claims fees have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims.

**LACK OF UNITY OF INVENTION**

The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

see sheet B

- All further search fees have been paid within the fixed time limit. The present European search report has been drawn up for all claims.
  
- As all searchable claims could be searched without effort justifying an additional fee, the Search Division did not invite payment of any additional fee.
  
- Only part of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the inventions in respect of which search fees have been paid, namely claims:
  
- None of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the invention first mentioned in the claims, namely claims:



The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

1. claims: 1,2,9,11,12,13,14,15,17,18,19,25

Piezoelectric or electrostrictive device with a base comprising two movable sections facing each other and a fixing part between these two sections, being entirely made from a single flat sheet of raw material. Method to produce such a device.

---

2. claims: 3-8, 10, 12, 14-17, 20-24,25

Piezoelectric or electrostrictive device with base comprising two movable sections facing each other, a fixing part between these two sections, and a mounting part at the other end of these two sections, being entirely made from a single flat sheet of raw material and method to produce such a device.

ANNEX TO THE EUROPEAN SEARCH REPORT  
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EP 02 25 0298

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Patent document cited in search report		Publication date		Patent family member(s)	Publication date
EP 0503762	A	16-09-1992	US	5227937 A	13-07-1993
			DE	69211038 D1	04-07-1996
			DE	69211038 T2	30-01-1997
			EP	0503762 A2	16-09-1992
			JP	2579101 B2	05-02-1997
			JP	5109037 A	30-04-1993
			KR	244899 B1	15-02-2000
EP 1020937	A	19-07-2000	JP	11026834 A	29-01-1999
			EP	1020937 A1	19-07-2000
			US	6262516 B1	17-07-2001
			WO	9901901 A1	14-01-1999
US 4612440	A	16-09-1986	DE	3332949 A1	04-04-1985
			GB	2146790 A , B	24-04-1985
US 5500777	A	19-03-1996	JP	3229432 B2	19-11-2001
			JP	6333222 A	02-12-1994
			JP	7240014 A	12-09-1995
DE 3021430	A	18-12-1980	JP	1394926 C	11-08-1987
			JP	56000026 A	06-01-1981
			JP	61061172 B	24-12-1986
			JP	1394927 C	11-08-1987
			JP	56000027 A	06-01-1981
			JP	61061173 B	24-12-1986
			AT	374942 B	12-06-1984
			AT	302880 A	15-10-1983
			AU	535786 B2	05-04-1984
			AU	5884780 A	11-12-1980
			BR	8003531 A	05-01-1981
			CH	650610 A5	31-07-1985
			DE	3021430 A1	18-12-1980
			DK	246480 A , B,	10-12-1980
			ES	8102392 A1	01-04-1981
			FR	2458866 A1	02-01-1981
			GB	2050671 A , B	07-01-1981
			IT	1131284 B	18-06-1986
			NL	8003359 A , B,	11-12-1980
			SE	451908 B	02-11-1987
			SE	8004231 A	10-12-1980
			SU	997619 A3	15-02-1983
			US	4441128 A	03-04-1984
US 5892640	A	06-04-1999	JP	10021519 A	23-01-1998

EPO FORM RD45P

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11-07-2005

Patent document cited in search report		Publication date		Patent family member(s)	Publication date
EP 0742597	A	13-11-1996	FR EP	2734051 A1 0742597 A1	15-11-1996 13-11-1996
GB 1328931	A	05-09-1973	NONE		
US 4438469	A	20-03-1984	JP JP JP AT AT AU AU CA DE FR GB NL	1438486 C 57060528 A 62045609 B 376314 B 419081 A 545557 B2 7561781 A 1157560 A1 3134480 A1 2491245 A1 2085641 A ,B 8104470 A	19-05-1988 12-04-1982 28-09-1987 12-11-1984 15-03-1984 18-07-1985 08-04-1982 22-11-1983 19-05-1982 02-04-1982 28-04-1982 16-04-1982
WO 0016318	A	23-03-2000	CN EP WO	1318192 A 1152401 A1 0016318 A1	17-10-2001 07-11-2001 23-03-2000
EP 1152401	A	07-11-2001	EP CN WO	1152401 A1 1318192 A 0016318 A1	07-11-2001 17-10-2001 23-03-2000
WO 9844488	A	08-10-1998	DE GB JP US WO	19882261 T0 2337848 A ,B 2001517349 T 6222706 B1 9844488 A1	24-02-2000 01-12-1999 02-10-2001 24-04-2001 08-10-1998
US 5923500	A	13-07-1999	DE DE EP HK JP JP SG US US US US US US US US	69316163 D1 69316163 T2 0597708 A2 1008158 A1 2752314 B2 6203508 A 48967 A1 5434731 A 5428490 A 5504640 A 5638234 A 6397455 B1 2002034051 A1 2002012202 A1	12-02-1998 16-04-1998 18-05-1994 30-04-1999 18-05-1998 22-07-1994 18-05-1998 18-07-1995 27-06-1995 02-04-1996 10-06-1997 04-06-2002 21-03-2002 31-01-2002

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Patent document cited in search report	Publication date	Patent family member(s)			Publication date
US 5923500	A			US 2002034039 A1	21-03-2002
US 5901014	A	04-05-1999	JP 2934126 B2	16-08-1999	
			JP 7057418 A	03-03-1995	
			US 2001016975 A1	30-08-2001	
			US 5612840 A	18-03-1997	
			US 2003107845 A1	12-06-2003	
			US 6522505 B1	18-02-2003	
			US 6560073 B1	06-05-2003	
			US 2005083610 A1	21-04-2005	
			US 6212041 B1	03-04-2001	
			US 6002548 A	14-12-1999	